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Safety warning notice

▲ WARNING! To reduce the possibility of heat-related injuries or of overheating the device, do not place the device directly on your lap or obstruct the device air vents. Use the device only on a hard, flat surface. Do not allow another hard surface, such as an adjoining optional printer, or a soft surface, such as pillows or rugs or clothing, to block airflow. Also, do not allow the AC adapter to contact the skin or a soft surface, such as pillows or rugs or clothing, during operation. The device and the AC adapter comply with the user-accessible surface temperature limits defined by the International Standard for Safety of Information Technology Equipment (IEC 60950).

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Product description

Category	Description	HP Mini 1101 NoteBook PC	HP Mini 110	Compaq Mini 110
Product Name	HP Mini 1101 NoteBook PC	\checkmark		
	HP Mini 110		\checkmark	
	Compaq Mini 110			\checkmark
Processor	Intel® Atom™ N280 1.66-GHz processor, 512-KB Level 2 cache, 533-MHz front-side bus (FSB)	\checkmark	\checkmark	\checkmark
	Intel Atom N270 1.6-GHz processor, 512-KB Level 2 cache, 533-MHz front- side bus (FSB)	\checkmark	\checkmark	V
Chipset	Northbridge: 945GSE; 533-MHz bus speed	\checkmark		\checkmark
	Southbridge: ICH7M		\checkmark	\checkmark
Graphics	Intel® Graphics Media Accelerator 950	\checkmark	\checkmark	\checkmark
	Universal Memory Architecture (UMA) graphics subsystem	\checkmark		\checkmark
Panels	All display assemblies include 1 webcam, 1 microphone, 1 speaker box, and 2 wireless local-area network (WLAN) antenna transceivers/cables; wireless wide-area network (WWAN) is optional	V	1	\checkmark
	Wide aspect 16:9 ratio panels		\checkmark	\checkmark
	10.1-inch standard-definition AntiGlare (1024 × 576) LED	\checkmark		\checkmark
Memory	One customer-accessible/upgradable memory module slot	\checkmark		\checkmark
	Supports up to 2 GB of system memory	\checkmark	\checkmark	
	PC2-4200, 533-MHz, DDR2	\checkmark	\checkmark	\checkmark
	Supports the following configurations:			

Category	Description	HP Mini 1101 NoteBook PC	HP Mini 110	Compaq Mini 110
	 512-MB total system memory (512 × 1) 			N
	NOTE: Supported by computers with Windows® XP Home Edition Service Pack 3 only.			
	 1024-MB total system memory (1024 × 1) 	\checkmark		\checkmark
	 2048-MB total system memory (2048 × 1) 	\checkmark		
	NOTE: Supported by computers with Windows XP Home Professional and HP Mobile Mi only.			
Mass storage devices	Solid-state drive (SSD) based on multi- level cell (MLC) technology	\checkmark		\checkmark
	8-GB	-	\checkmark	\checkmark
	16-GB		\checkmark	\checkmark
	32-GB		\checkmark	
	64-GB	\checkmark		
	NOTE: Available only for HP 1101 NoteBook PCs, and HP Mini 110 models with Mobile Mi installed.			
Hard drive	Supports all 9.5-mm, 6.35-cm (2.50- inch) parallel SATA hard drives (optional)	\checkmark	V	V
	160-GB, 5400-RPM		\checkmark	\checkmark
	250-GB, 5400-RPM		\checkmark	\checkmark
	NOTE: Available only for HP 1101 NoteBook PCs, and HP Mini 110s with Mobile Mi installed.			
Optical drive	Supports external USB optical drives only	\checkmark		\checkmark
Diskette drive	Supports external USB diskette drives only	\checkmark	\checkmark	\checkmark
Audio/Visual	high-definition (HD) audio	\checkmark		\checkmark
	Integrated speakers (2)		\checkmark	
	Fixed integrated microphone		\checkmark	
	Fixed integrated VGA webcam, 640 × 480 resolution, up to 30 frames per second	\checkmark	\checkmark	\checkmark
Modem	Supports external USB modems only	\checkmark	\checkmark	\checkmark
Ethernet	Integrated 10/100 network interface card (NIC)	\checkmark	\checkmark	\checkmark

Category	Description	HP Mini 1101 NoteBook PC	HP Mini 110	Compaq Mini 110
Wireless	2 WLAN antennas built into display assembly	\checkmark	\checkmark	
	Integrated WLAN by way of 802.11b/g WLAN module	\checkmark	\checkmark	N
	Integrated WWAN by way of HP un2400 Mobile Broadband Module (optional)	\checkmark		\checkmark
	NOTE: Not available in HP Mini 110 models with Mobile Mi installed.			
External media cards	Digital Media Slot (consumer models) or Media Card Reader (commercial models) with push-push technology supporting:	\checkmark	1	V
	Memory Stick (MS)			
	Memory Stick Pro (MSP)			
	MultiMediaCard (MMC)			
	Secure Digital (SD) Memory Card			
	• xD-Picture Card (XD)			
	HP Mini Mobile Drive Bay (on models equipped with a solid-state drive)			\checkmark
Internal media	Two Mini Card slots:		\checkmark	
cards	Full-size Mini Card slot			
	Half-size Mini Card slot			
Ports	Audio-in (stereo microphone)			
	Audio-in/out (microphone/stereo headphone)	\checkmark	V	\checkmark
	RJ-45 (Ethernet, includes link and activity lights)	\checkmark	\checkmark	\checkmark
	USB (2–3)	\checkmark	\checkmark	\checkmark
	3-pin AC power	\checkmark	\checkmark	\checkmark
Keyboard/ pointing device	92% keyboard	\checkmark	\checkmark	\checkmark
	TouchPad, with 2 TouchPad buttons and 2-way scrolling (taps enabled as default)	\checkmark	\checkmark	V
Power requirements	30-W UMA AC adapter (non-Smart) with localized cable plug support	\checkmark		\checkmark
	AC adapter connector on cable	\checkmark	\checkmark	\checkmark
	3-cell lithium-polymer (Li-Pol) battery (2.55-Ah, 28-Wh), 3-hour target life	\checkmark		\checkmark
	6-cell lithium-polymer (Li-Pol) battery (2.55-Ah, 55-Wh), 6-hour target life	\checkmark	\checkmark	\checkmark

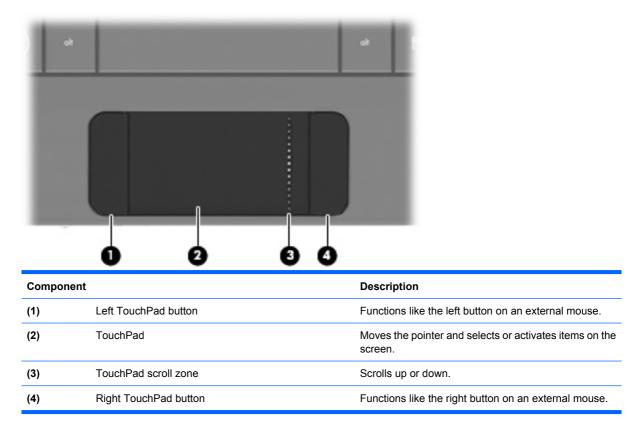
Category	Description	HP Mini 1101 NoteBook PC	HP Mini 110	Compaq Mini 110
Security	Supports HP Kensington Security Lock	\checkmark	\checkmark	\checkmark
Operating system	Preinstalled:			
	Windows® XP Home SP3, ultra low-cost personal computer (ULCPC) edition		\checkmark	\checkmark
	Windows Vista® Business 32 (with XP Pro image)	\checkmark		
	HP Mobile Mi		\checkmark	
Serviceability	End-user replaceable parts:			
	AC adapter	\checkmark	\checkmark	\checkmark
	Battery (system)	\checkmark	\checkmark	\checkmark
	Hard drive	\checkmark	\checkmark	\checkmark
	Keyboard	\checkmark	\checkmark	\checkmark
	Memory module	\checkmark	\checkmark	\checkmark
	Solid-state drive		\checkmark	V

2 External component identification

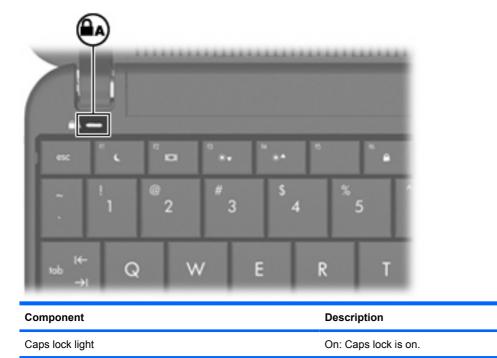
Components included with the device may vary by region and model. The illustrations in this chapter identify the standard features on most device models.

Top components

TouchPad

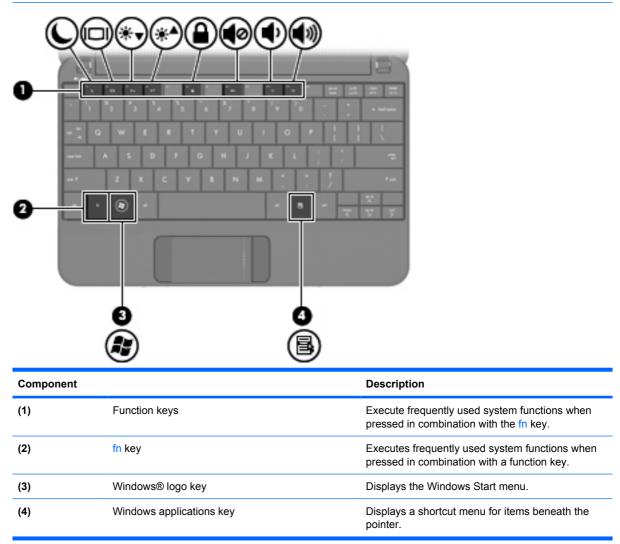


Light



Keys

NOTE: Refer to the illustration that most closely matches your computer.



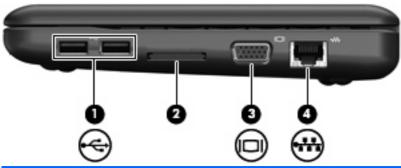
Compone	nt	Description
(1)	Function keys	Execute frequently used system functions when pressed in combination with the fn key.
(2)	fn key	Executes frequently used system functions when pressed in combination with a function key.
(3)	Home key	Returns to the Home Screen.
(4)	Program Switcher key	Displays the Start New Program button from anywhere on the device.

Front components

		9 9 (1 ¹)
Compone	nt	Description
(1)	Power light	 On: The device is on. Blinking: The device is in the Sleep state (Windows Vista) or Standby (Windows XP or Mobile Mi). Off: The device is off or in Hibernation.
(2)	Power switch	 Oil. The device is on of in Hiberhaldon. When the device is off, slide the switch to turn on the device. When the device is on, briefly slide the switch to initiate Hibernation. When the device is in the Sleep state (Windows Vista) or Standby (Windows XP or Mobile Mi), briefly slide the switch to exit the Sleep state (Windows Vista) or Standby (Windows XP or Mobile Mi). When the device is in Hibernation, briefly slide the switch to exit Hibernation. If the device has stopped responding and operating system shutdown procedures are ineffective, slide and hold the power switch for at least 5 seconds to turn off the device.
(3)	Drive light	Blinking: The hard drive or flash drive is being accessed.
(4)	Battery light	 On: A battery is charging. Blinking: A battery that is the available only power source has reached a low battery level. When the battery reaches a critical battery level, the battery light begins blinking rapidly. Off: If the device is plugged into an external power source, the light turns off when all batteries in the device are fully charged. If the device is not plugged into an external power source, the light stays off until the battery reaches a low battery reaches a low battery level.

Component		Description
(5)	Wireless light	 Blue: An integrated wireless device, such as a wireless local area network (WLAN) device, is on.
		• Amber: All wireless devices are off.
(6)	Wireless switch	Turns the wireless feature on or off, but does not establish a wireless connection.
		NOTE: A wireless network must be set up in order to establish a wireless connection.

Right-side components



Component		Description
(1)	USB ports (2)	Connect optional USB devices.
(2)	Digital Media Slot (consumer models) or Media Card Reader (commercial models)	 Supports the following optional digital card formats: Memory Stick (MS) Memory Stick Pro (MSP) MultiMediaCard (MMC) Secure Digital (SD) Memory Card xD-Picture Card
(3)	External monitor port	Connects an optional external display, such as a monitor or projector, to the device.
(4)	RJ-45 (network) jack	Connects a network cable.

Left-side components

Component		Description
(1)	Security cable slot	Attaches an optional security cable to the device.
		NOTE: The security cable is designed to act as a deterrent, but it may not prevent the device from being mishandled or stolen.
(2)	Power connector	Connects an AC adapter.
(3)	AC adapter light	Indicates AC power connection.
(4)	Vent	Enables airflow to cool internal components.
		NOTE: The device fan starts up automatically to cool internal components and prevent overheating. It is normal for the internal fan to cycle on and off during routine operation.
(5)	USB port	Connects an optional USB device.
(6)	Audio-out (headphone) jack/Audio-in (microphone) jack	Produces sound when connected to optional powered stereo speakers, headphones, earbuds, a headset, or television audio. Also connects an optional headset microphone.

WARNING! To reduce the risk of personal injury, adjust the volume before putting on headphones, earbuds, or a headset. For additional safety information, refer to the *Regulatory, Safety and Environmental Notices*.

NOTE: When an audio component is connected to the jack, the device speakers are disabled.

The audio component cable must have a 4-conductor connector.

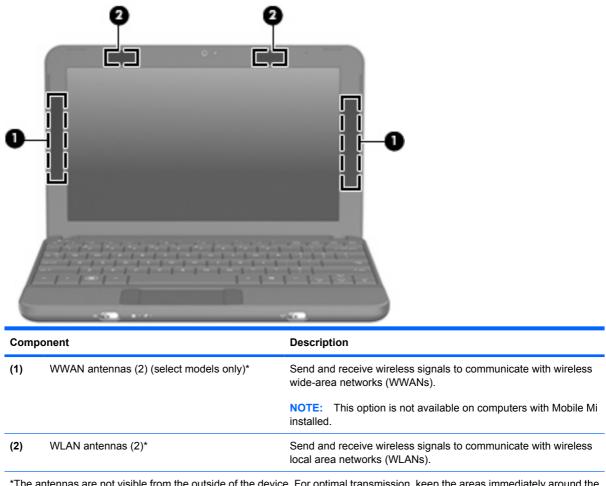
Display components

	QQ	6
0- 0-		
Comp	onent	Description
Compo (1)	onent Speakers (2)	Description Produce sound.
(1)	Speakers (2)	Produce sound. Turns off the display if the display is closed while the
(1)	Speakers (2)	Produce sound. Turns off the display if the display is closed while the power is on. NOTE: The display switch is not visible from the
(1) (2)	Speakers (2) Internal display switch	Produce sound. Turns off the display if the display is closed while the power is on. NOTE: The display switch is not visible from the outside of the device.
(1) (2)	Speakers (2) Internal display switch	Produce sound. Turns off the display if the display is closed while the power is on. NOTE: The display switch is not visible from the outside of the device. Captures still photographs and videos. NOTE: To capture videos, you need to install additional

Bottom components

	•	
MI O		
Compon	ent	Description
(1)	Battery bay	Holds the battery.
(2)	Battery release latches (2)	Release the battery from the battery bay.
(3)	Vent	Enables airflow to cool internal components.
		NOTE: The device fan starts up automatically to cool internal components and prevent overheating. It is normal for the internal fan to cycle on and off during routine operation.
(4)	Memory module compartment	Contains the memory module slot.

Wireless antennas



*The antennas are not visible from the outside of the device. For optimal transmission, keep the areas immediately around the antennas free from obstructions.

To see wireless regulatory notices, refer to the section of the *Regulatory, Safety and Environmental Notices* that applies to your country or region.

3 Illustrated parts catalog

Service tag

When ordering parts or requesting information, provide the computer serial number and model description provided on the service tag:

(1) Product name: This is the product name affixed to the front of the device.

(2) Serial number (s/n): This is an alphanumeric identifier that is unique to each product.

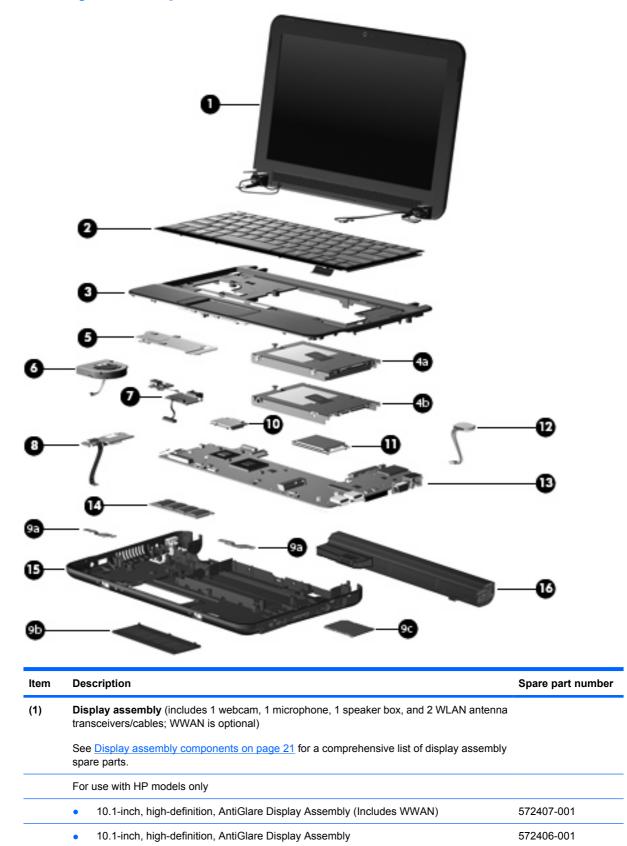
(3) Part number/Product number (p/n): This number provides specific information about the product's hardware components. The part number helps a service technician to determine what components and parts are needed.

(4) Model description: This is the alphanumeric identifier used to locate documents, drivers, and support for the device.

(5) Warranty period: This number describes the duration of the warranty period for the device.



Device major components

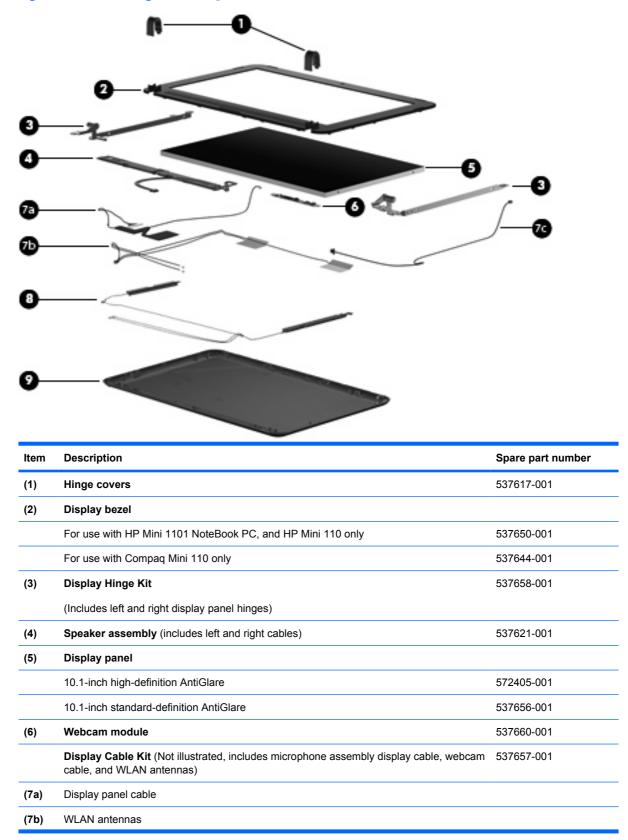


ltem	Description	Spare part numbe			
	10.1-inch, standard-definition, AntiGlare Display Assembly (includes WWAN)	571414-001			
	10.1-inch, standard-definition, AntiGlare Display Assembly	537646-001			
	For use with Compaq models only				
	10.1-inch, high-definition, AntiGlare Display Assembly	572414-001			
	10.1-inch, standard-definition, AntiGlare Display Assembly (includes WWAN)	571417-001			
	10.1-inch, standard-definition, AntiGlare Display Assembly	537643-001			
2)	Keyboard				
	For use only on models with Windows operating system installed				
	For use only in Brazil	535689-201			
	For use only in the Czech Republic	535689-221			
	For use only in Europe	535689-A41			
	For use only in France	535689-051			
	For use only in French Canada	535689-121			
	For use only in Finland, Norway, and Sweden	535689-DH1			
	For use only in Germany	535689-041			
	For use only in Greece	535689-151			
	For use only in Hungary	535689-211			
	For use on international models	535689-B31			
	For use only in Israel	535689-BB1			
	• For use only in Italy	535689-061			
	For use only in Japan	535689-291			
	For use only in Latin America	535689-161			
	For use only in Portugal	535689-131			
	For use only in Russia	535689-251			
	For use only in Saudi Arabia	535689-171			
	For use only South Korea	535689-AD1			
	For use only in Spain	535689-071			
	For use only in Switzerland	535689-111			
	For use only in Taiwan	535689-AB1			
	For use only in Thailand	535689-281			
	For use only in Turkey	535689-141			
	For use only in the United Kingdom	535689-031			
	For use only in the United States	535689-001			

ltem	Description	Spare part number	
	For use only in Brazil	535690-201	
	For use only in French Canada	535690-121	
	For use only in Japan	535690-291	
	For use only in Latin America	535690-161	
	For use only in South Korea	535690-AD1	
	For use only in Taiwan	535690-AB1	
	For use only in Thailand	535690-281	
	For use only in the United States	535690-001	
(3)	Top cover (includes TouchPad)	537622-001	
	Mass storage devices		
	NOTE: Each hard drive spare part kit and solid-state drive spare part kit includes a bracket and screws.		
(4a)	Hard drive (select models only)		
	See Mass storage devices on page 23 for a comprehensive list of hard drive spare parts.		
(4b)	b) Solid-state drive		
	See Mass storage devices on page 23 for a comprehensive list of solid-state drive spare parts.		
(5)	Heat sink assembly (includes replacement thermal material)	537619-001	
(6)	Fan	537613-001	
(7)	USB/audio board (includes cable)	537614-001	
(8)	Power/battery pass-through board	537615-001	
	Plastics/actuator Kit	537612-001	
(9a)	Power switch and wireless switch actuators		
(9b)	Memory module compartment cover		
(9c)	(9c) Bezel for Digital Media Slot (consumer models) or Media Card Reader (commercial models)		
	Wireless modules		
(10)	WLAN module		
	Broadcom 4312 802.11/b/g WLAN module		
	 For use in Canada, the Cayman Islands, Guam, Puerto Rico, the U.S. Virgin Islands, and the United States 	504593-003	

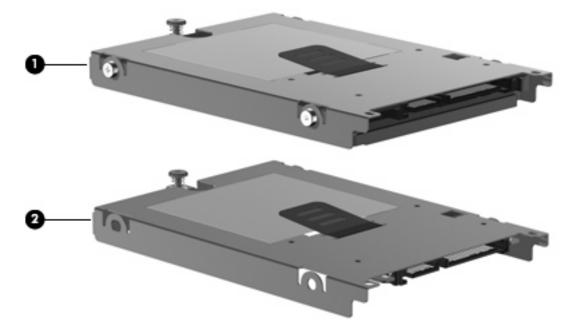
ltem	Description	Spare part number	
	 For use in Afghanistan, Albania, Algeria, Andorra, Angola, Antigua and Barbuda, Argentina, Armenia, Aruba, Australia, Austria, Azerbaijan, the Bahamas, Bahrain, Bangladesh, Barbados, Belarus, Belgium, Belize, Benin, Bermuda, Bhutan, Bolivia, Bosnia and Herzegovina, Botswana, Brazil, the British Virgin Islands, Brunei, Bulgaria, Burkina Faso, Burundi, Cameroon, Cape Verde, the Central African Republic, Chad, Chile, the People's Republic of China, Colombia, Comoros, the Congo, Costa Rica, Croatia, Cyprus, the Czech Republic, Denmark, Djibouti, Dominica, the Dominican Republic, East Timor, Ecuador, Egypt, El Salvador, Equatorial Guinea, Eritrea, Estonia, Ethiopia, Fiji, Finland, France, French Guiana, Gabon, Gambia, Georgia, Germany, Ghana, Gibraltar, Greece, Grenada, Guadeloupe, Guatemala, Guinea, Guinea-Bissau, Guyana, Haiti, Honduras, Hong Kong, Hungary, Iceland, India, Ireland, Israel, Italy, the Ivory Coast, Jamaica, Jordan, Kazakhstan, Kenya, Kiribati, Kyrgyzstan, Laos, Latvia, Lebanon, Lesotho, Liberia, Liechtenstein, Lithuania, Luxembourg, Macedonia, Madagascar, Malawi, Malaysia, the Maldives, Mali, Malta, the Marshall Islands, Martinique, Mauritania, Mauritius, Mexico, Micronesia, Monaco, Mongolia, Montenegro, Morocco, Mozambique, Namibia, Nauru, Nepal, the Nether Antilles, the Netherlands, New Zealand, Nicaragua, Niger, Nigeria, Norway, Oman, Pakistan, Palau, Panama, Papua New Guinea, Paraguay, Peru, the Philippines, Poland, Portugal, the Republic of Moldova, Romania, Russia, Rwanda, Samoa, San Marino, Sao Tome and Principe, Saudi Arabia, Senegal, Serbia, the Seychelles, Sierra Leone, Singapore, Slovakia, Slovenia, the Solomon Islands, Somalia, South Africa, South Korea, Spain, Sri Lanka, St. Kitts and Nevis, St. Lucia, St. Vincent and the Grenadines, Suriname, Swaziland, Sweden, Switzerland, Taiwan, Tajikistan, Tanzania, Togo, Tonga, Trinidad and Tobago, Tunisia, Turkey, Turkmenistan, Tuvalu, Uganda, Ukraine, the United Arab Emirates, the United Kingdom, Uruguay, Uzbekistan, Vanuatu, Venezu	504593-004	
(11)	WWAN module		
	NOTE: Not available for computers with Mobile Mi installed.		
	HP un2400 Mobile Broadband Module (select models only)	483377-002	
	HP un2400 Mobile Broadband Module for use only with Verizon Wireless (select models only)	483377-003	
	WWAN module for use only in China	571888-001	
(12)	RTC battery	537616-001	
(13)	System board (includes processor and replacement thermal material)		
	Includes Intel Atom N280 1.66-GHz processor, 512-KB Level 2 cache, 533-MHz front-side bus (FSB)	571370-001	
	Includes Intel Atom N270 1.6-GHz processor, 512-KB Level 2 cache, 533-MHz front-side bus (FSB)	537662-001	
(14)	Memory module (PC2-5300, 533-MHz, DDR2)		
	512-MB (for use in HP Mini 110 and Compaq Mini 110 models only)	537663-001	
	1024-MB	537664-001	
	2048-MB (for use in HP Mini 1101 NoteBook PC, and HP Mini 110 with Mobile Mi installed only)	537665-001	
(15)	Base enclosure (includes 4 rubber feet)	537611-001	
(16)	Battery		
	6-cell lithium-polymer (Li-Pol) battery (2.55-Ah, 55-Wh)	537627-001	

Display assembly components



ltem	Description	Spare part number
(7c)	Microphone assembly	
(8)	WWAN antennas (not available on computers with Mobile Mi installed.)	537655-001
(9)	Display enclosure (includes logo)	
	For use with the HP Mini 1101 Notebook PC, and HP Mini 110	537651-001
	For use with the Compaq Mini 110	537645-001
	Display Screw Kit (not illustrated)	538510-001

Mass storage devices



NOTE: Each hard drive spare part kit and solid-state drive spare part kit includes a cable and bracket.

ltem	Description	Spare part number
(1)	Hard drive (select models only)	
	250-GB, 5400-RPM	537635-001
	160-GB, 5400-RPM	537634-001
	Hard Drive Hardware Kit (not illustrated)	537641-001
(2)	Solid-state drive	
	64-GB	537640-001
	32-GB	537639-001
	16-GB	537638-001
	8-GB	537637-001
	Solid-state Drive Hardware Kit (not illustrated)	537642-001

Miscellaneous parts

Description Spare part nu	
30-W UMA AC adapter	496813-001
Bluetooth® adapter	574670-001
Power cords	
For use in Argentina	490371-D01
For use in Australia	490371-011
For use in Brazil	490371-201
For use in China	490371-AA1
For use in Denmark	490371-081
For use in Europe	490371-021
For use in India	490371-D61
For use in Israel	490371-BB1
For use in Italy	490371-061
For use in Japan	490371-291
For use in North America	490371-001
For use in Singapore and the United Kingdom	490371-031
For use in South Africa	490371-AR1
For use in South Korea	490371-AD1
For use in Switzerland	490371-111
For use in Taiwan	490371-AB1
Rubber Kit (contains 4 device feet)	537618-001
Screw Kit 537620-001	

Sequential part number listing

Spare part number	Description
483377-002	HP un2400 Mobile Broadband Module (select models only)
483377-003	HP un2400 Mobile Broadband Module for use with Verizon Wireless only (select models only)
490371-001	Power cord for use in North America
490371-011	Power cord for use in Australia
490371-021	Power cord for use in Europe
490371-031	Power cord for use in Singapore and the United Kingdom
490371-061	Power cord for use in Italy
490371-081	Power cord for use in Denmark
490371-111	Power cord for use in Switzerland
490371-201	Power cord for use in Brazil
490371-291	Power cord for use in Japan
490371-AA1	Power cord for use in China
490371-AB1	Power cord for use in Taiwan
490371-AD1	Power cord for use in South Korea
490371-AR1	Power cord for use in South Africa
490371-BB1	Power cord for use in Israel
490371-D01	Power cord for use in Argentina
490371-D61	Power cord for use in India
496813-001	30-W UMA AC adapter
504593-003	Broadcom 4312 802.11/b/g WLAN module for use in Canada, the Cayman Islands, Guam, Puerto Rico, the U.S. Virgin Islands, and the United States
504593-004	Broadcom 4312 802.11/b/g WLAN module for use in Afghanistan, Albania, Algeria, Andorra, Angola, Antigua and Barbuda, Argentina, Armenia, Aruba, Australia, Austria, Azerbaijan, the Bahamas, Bahrain, Bangladesh, Barbados, Belarus, Belgium, Belize, Benin, Bermuda, Bhutan, Bolivia, Bosnia and Herzegovina, Botswana, Brazil, the British Virgin Islands, Brunei, Bulgaria, Burkina Faso, Burundi, Cameroon, Cape Verde, the Central African Republic, Chad, Chile, the People's Republic of China, Colombia, Comoros, the Congo, Costa Rica, Croatia, Cyprus, the Czech Republic, Denmark, Djibouti, Dominica, the Dominican Republic, East Timor, Ecuador, Egypt, El Salvador, Equatorial Guinea, Eritrea, Estonia, Ethiopia, Fiji, Finland, France, French Guiana, Gabon, Gambia, Georgia, Germany, Ghana, Gibraltar, Greece, Grenada, Guadeloupe, Guatemala, Guinea, Guinea-Bissau, Guyana, Haiti, Honduras, Hong Kong, Hungary, Iceland, India, Ireland, Israel, Italy, the Ivory Coast, Jamaica, Jordan, Kazakhstan, Kenya, Kiribati, Kyrgyzstan, Laos, Latvia, Lebanon, Lesotho, Liberia, Liechtenstein, Lithuania, Luxembourg, Macedonia, Madagascar, Malawi, Malaysia, the Maldives, Mali, Malta, the Marshall Islands, Martinique, Mauritania, Mauritius, Mexico, Micronesia, Monaco, Mongolia, Montenegro, Morocco, Mozambique, Namibia, Nauru, Nepal, the Nether Antilles, the Netherlands, New Zealand, Nicaragua, Niger, Nigeria, Norway, Oman, Pakistan, Palau, Panama, Papua New Guinea, Paraguay, Peru, the Philippines, Poland, Portugal, the Republic of Moldova, Romania, Russia, Rwanda, Samoa, San Marino, Sao Tome and Principe, Saudi Arabia, Senegal, Serbia, the Seychelles, Sierra Leone, Singapore, Slovakia, Slovenia, the Solomon Islands, Somalia, South Africa, South Korea, Spain, Sri Lanka, St. Kitts and Nevis, St. Lucia, St. Vincent and the Grenadines, Suriname, Swaziland, Sweden, Switzerland, Taiwan, Tajikistan, Tanzania, Togo, Tonga, Trinidad and Tobago, Tunisia, Turkey, Turkmenistan, Tuvalu, Uganda, Ukraine, the United Arab Emirates, the United Kingdom, Uruguay, Uzb

Spare part number	Description
535689-001	Keyboard for use only in the United States on models with Windows operating system installed
535689-031	Keyboard for use only in the United Kingdom on models with Windows operating system installed
535689-041	Keyboard for use only in Germany on models with Windows operating system installed
535689-051	Keyboard for use only in France on models with Windows operating system installed
535689-061	Keyboard for use only in Italy on models with Windows operating system installed
535689-071	Keyboard for use only in Spain on models with Windows operating system installed
535689-121	Keyboard for use only in French Canada on models with Windows operating system installed
535689-131	Keyboard for use only in Portugal on models with Windows operating system installed
535689-141	Keyboard for use only in Turkey on models with Windows operating system installed
535689-161	Keyboard for use only in Latin America on models with Windows operating system installed
535689-171	Keyboard for use only in Saudi Arabia on models with Windows operating system installed
535689-201	Keyboard for use only in Brazil on models with Windows operating system installed
535689-211	Keyboard for use only in Hungary on models with Windows operating system installed
535689-221	Keyboard for use only in the Czech Republic on models with Windows operating system installed
535689-251	Keyboard for use only in Russia on models with Windows operating system installed
535689-281	Keyboard for use only in Thailand on models with Windows operating system installed
535689-291	Keyboard for use only in Japan on models with Windows operating system installed
535689-A41	Keyboard for use only in Europe on models with Windows operating system installed
535689-AB1	Keyboard for use only in Taiwan on models with Windows operating system installed
535689-AD1	Keyboard for use only in South Korea on models with Windows operating system installed
535689-B31	Keyboard for use only in international models with Windows operating system installed
535689-BB1	Keyboard for use only in Israel on models with Windows operating system installed
535689-DH1	Keyboard for use only in Finland, Norway and Sweden on models with Windows operating system installed
535690-001	Keyboard for use only in the United States on models with Mobile Mi installed
535690-121	Keyboard for use only in French Canada on models with Mobile Mi installed
535690-161	Keyboard for use only in Latin America on models with Mobile Mi installed
535690-201	Keyboard for use only in Brazil on models with Mobile Mi installed
535690-281	Keyboard for use only in Thailand on models with Mobile Mi installed
535690-291	Keyboard for use only in Japan on models with Mobile Mi installed
535690-AB1	Keyboard for use only in Taiwan on models with Mobile Mi installed
535690-AD1	Keyboard for use only in South Korea on models with Mobile Mi installed
537611-001	Base enclosure (includes 4 rubber feet)
537612-001	Plastics/actuator kit (includes power switch and wireless switch actuators, memory module compartment cover, and bezel for Digital Media Slot (consumer models) or Media Card Reader (commercial models)

Spare part number	Description
537613-001	Fan
537614-001	USB/audio board (includes cable)
537615-001	Power/battery pass-through board
537616-001	RTC battery
537617-001	Display assembly hinge covers
537618-001	Rubber Kit (contains 4 device feet)
537619-001	Heat sink assembly (includes replacement thermal material)
537620-001	Screw Kit
537621-001	Speaker assembly (includes left and right cables)
537622-001	Top cover (includes TouchPad)
537626-001	3-cell lithium-polymer (Li-Pol) battery (2.55-Ah, 28-Wh)
537627-001	6-cell lithium-polymer (Li-Pol) battery (2.55-Ah, 55-Wh)
537634-001	160-GB hard drive, 5400-RPM
537635-001	250-GB hard drive, 5400-RPM
537637-001	8-GB solid-state drive
537638-001	16-GB solid-state drive
537639-001	32-GB solid-state drive
537640-001	64-GB solid-state drive
537641-001	Hard Drive Hardware Kit
537642-001	Solid-state Drive Hardware Kit
537643-001	10.1-inch, standard-definition, AntiGlare Display Assembly for use with Compaq standard models only
537644-001	Display bezel for use with Compaq Mini 110 only
537645-001	Display enclosure (includes logo) for use with the Compaq Mini 110
537646-001	10.1-inch, standard-definition, AntiGlare Display Assembly for use with HP models only
537650-001	Display bezel for use with HP Mini 1101 NoteBook PC, and HP Mini 110 only
537651-001	Display enclosure (includes logo) for use with the HP Mini 1101 Notebook PC, and HP Mini 110
537655-001	WWAN antennas
537656-001	10.1-inch standard-definition AntiGlare display panel
537657-001	Display Cable Kit (includes microphone assembly display cable, webcam cable, and WLAN antennas)
537658-001	Display Hinge Kit (Includes left and right display panel hinges)
537660-001	Webcam module
537662-001	System board (Includes Intel Atom N270 1.6-GHz processor, 512-KB Level 2 cache, 533-MHz front-side bus (FSB), and replacement thermal material)

Spare part number	Description
537663-001	512-MB memory module (PC2-5300, 533-MHz, DDR2 for use in HP Mini 110 and Compaq Mini 110 models only)
537664-001	1024-MB memory module (PC2-5300, 533-MHz, DDR2 for use in HP Mini 110 and Compaq Mini 110 models only)
537665-001	2048-MB memory module (PC2-5300, 533-MHz, DDR2 for use in HP Mini 110 and Compaq Mini 110 models only)
538510-001	Display Screw Kit (not illustrated)
571370-001	System board (Includes Intel Atom N280 1.66-GHz processor, 512-KB Level 2 cache, 533-MHz front-side bus (FSB), and replacement thermal material)
571414-001	10.1-inch, standard-definition, AntiGlare Display Assembly (includes WWAN) for use with HP models only
571417-001	10.1-inch, standard-definition, AntiGlare Display Assembly (includes WWAN) for use with Compaq standard models only
571888-001	WWAN module, for use only in China
572405-001	10.1-inch high-definition AntiGlare display panel
572406-001	10.1-inch, high-definition, AntiGlare Display Assembly for use with HP models only
572407-001	10.1-inch, high-definition, AntiGlare Display Assembly (Includes WWAN) for use with HP models only
572414-001	10.1-inch, high-definition, AntiGlare Display Assembly for use with Compaq standard models only
574670-001	Bluetooth adapter

4 Removal and replacement procedures

Preliminary replacement requirements

Tools required

You will need the following tools to complete the removal and replacement procedures:

- Flat-bladed screwdriver
- Magnetic screwdriver
- Phillips P0 and P1 screwdrivers

Service considerations

The following sections include some of the considerations that you must keep in mind during disassembly and assembly procedures.

NOTE: As you remove each subassembly from the device, place the subassembly (and all accompanying screws) away from the work area to prevent damage.

Plastic parts

△ CAUTION: Using excessive force during disassembly and reassembly can damage plastic parts. Use care when handling the plastic parts. Apply pressure only at the points designated in the maintenance instructions.

Cables and connectors

△ CAUTION: When servicing the device, be sure that cables are placed in their proper locations during the reassembly process. Improper cable placement can damage the device.

Cables must be handled with extreme care to avoid damage. Apply only the tension required to unseat or seat the cables during removal and insertion. Handle cables by the connector whenever possible. In all cases, avoid bending, twisting, or tearing cables. Be sure that cables are routed in such a way that they cannot be caught or snagged by parts being removed or replaced. Handle flex cables with extreme care; these cables tear easily.

Drive handling

△ CAUTION: Drives are fragile components that must be handled with care. To prevent damage to the device, damage to a drive, or loss of information, observe these precautions:

Before removing or inserting a hard drive, shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.

Before handling a drive, be sure that you are discharged of static electricity. While handling a drive, avoid touching the connector.

Handle drives on surfaces covered with at least one inch of shock-proof foam.

Avoid dropping drives from any height onto any surface.

After removing a hard drive, an optical drive, or a diskette drive, place it in a static-proof bag.

Avoid exposing a hard drive to products that have magnetic fields, such as monitors or speakers.

Avoid exposing a drive to temperature extremes or liquids.

If a drive must be mailed, place the drive in a bubble pack mailer or other suitable form of protective packaging and label the package "FRAGILE."

Grounding guidelines

Electrostatic discharge damage

Electronic components are sensitive to electrostatic discharge (ESD). Circuitry design and structure determine the degree of sensitivity. Networks built into many integrated circuits provide some protection, but in many cases, ESD contains enough power to alter device parameters or melt silicon junctions.

A discharge of static electricity from a finger or other conductor can destroy static-sensitive devices or microcircuitry. Even if the spark is neither felt nor heard, damage may have occurred.

An electronic device exposed to ESD may not be affected at all and can work perfectly throughout a normal cycle. Or the device may function normally for a while, then degrade in the internal layers, reducing its life expectancy.

△ CAUTION: To prevent damage to the device when you are removing or installing internal components, observe these precautions:

Keep components in their electrostatic-safe containers until you are ready to install them.

Use nonmagnetic tools.

Before touching an electronic component, discharge static electricity by using the guidelines described in this section.

Avoid touching pins, leads, and circuitry. Handle electronic components as little as possible.

If you remove a component, place it in an electrostatic-safe container.

The following table shows how humidity affects the electrostatic voltage levels generated by different activities.

\triangle CAUTION: A product can be degraded by as little as 700 V.

Typical electrostatic voltage levels			
		Relative humidity	
Event	10%	40%	55%
Walking across carpet	35,000 V	15,000 V	7,500 V
Walking across vinyl floor	12,000 V	5,000 V	3,000 V
Motions of bench worker	6,000 V	800 V	400 V
Removing DIPS from plastic tube	2,000 V	700 V	400 V
Removing DIPS from vinyl tray	11,500 V	4,000 V	2,000 V
Removing DIPS from Styrofoam	14,500 V	5,000 V	3,500 V
Removing bubble pack from PCB	26,500 V	20,000 V	7,000 V
Packing PCBs in foam-lined box	21,000 V	11,000 V	5,000 V

Packaging and transporting guidelines

Follow these grounding guidelines when packaging and transporting equipment:

- To avoid hand contact, transport products in static-safe tubes, bags, or boxes.
- Protect ESD-sensitive parts and assemblies with conductive or approved containers or packaging.
- Keep ESD-sensitive parts in their containers until the parts arrive at static-free workstations.
- Place items on a grounded surface before removing items from their containers.
- Always be properly grounded when touching a component or assembly.
- Store reusable ESD-sensitive parts from assemblies in protective packaging or nonconductive foam.
- Use transporters and conveyors made of antistatic belts and roller bushings. Be sure that
 mechanized equipment used for moving materials is wired to ground and that proper materials are
 selected to avoid static charging. When grounding is not possible, use an ionizer to dissipate
 electric charges.

Workstation guidelines

Follow these grounding workstation guidelines:

- Cover the workstation with approved static-shielding material.
- Use a wrist strap connected to a properly grounded work surface and use properly grounded tools and equipment.
- Use conductive field service tools, such as cutters, screwdrivers, and vacuums.
- When fixtures must directly contact dissipative surfaces, use fixtures made only of static-safe materials.
- Keep the work area free of nonconductive materials, such as ordinary plastic assembly aids and Styrofoam.
- Handle ESD-sensitive components, parts, and assemblies by the case or PCM laminate. Handle these items only at static-free workstations.
- Avoid contact with pins, leads, or circuitry.
- Turn off power and input signals before inserting or removing connectors or test equipment.

Equipment guidelines

Grounding equipment must include either a wrist strap or a foot strap at a grounded workstation.

- When seated, wear a wrist strap connected to a grounded system. Wrist straps are flexible straps with a minimum of one megohm ±10% resistance in the ground cords. To provide proper ground, wear a strap snugly against the skin at all times. On grounded mats with banana-plug connectors, use alligator clips to connect a wrist strap.
- When standing, use foot straps and a grounded floor mat. Foot straps (heel, toe, or boot straps) can be used at standing workstations and are compatible with most types of shoes or boots. On conductive floors or dissipative floor mats, use foot straps on both feet with a minimum of one megohm resistance between the operator and ground. To be effective, the conductive strips must be worn in contact with the skin.

The following grounding equipment is recommended to prevent electrostatic damage:

- Antistatic tape
- Antistatic smocks, aprons, and sleeve protectors
- Conductive bins and other assembly or soldering aids
- Nonconductive foam
- Conductive tabletop workstations with ground cords of one megohm resistance
- Static-dissipative tables or floor mats with hard ties to the ground
- Field service kits
- Static awareness labels
- Material-handling packages
- Nonconductive plastic bags, tubes, or boxes
- Metal tote boxes
- Electrostatic voltage levels and protective materials

The following table lists the shielding protection provided by antistatic bags and floor mats.

Material	Use	Voltage protection level
Antistatic plastic	Bags	1,500 V
Carbon-loaded plastic	Floor mats	7,500 V
Metallized laminate	Floor mats	5,000 V

Component replacement procedures

This chapter provides removal and replacement procedures.

There are as many as 65 screws, in 9 different sizes, that must be removed, replaced, or loosened when servicing the device. Make special note of each screw size and location during removal and replacement.

Service tag

When ordering parts or requesting information, provide the computer serial number and model description provided on the service tag:

(1) Product name: This is the product name affixed to the front of the device.

(2) Serial number (s/n): This is an alphanumeric identifier that is unique to each product.

(3) Part number/Product number (p/n): This number provides specific information about the product's hardware components. The part number helps a service technician to determine what components and parts are needed.

(4) Model description: This is the alphanumeric identifier used to locate documents, drivers, and support for the device.

(5) Warranty period: This number describes the duration of the warranty period for the device.

000		CCCCXXXXXXXCCX XXX IIIIIIIIIIIIIIIIIIIII	
•	tag	xxxxxxxx warranty x year	-0 6

Device feet

The device feet are adhesive-backed rubber pads, tethered to the base enclosure.

Description	Spare part number
Rubber Kit	537618-001



Battery

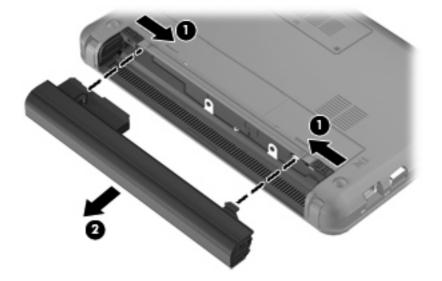
Description	Spare part number
6-cell lithium-polymer (Li-Pol) battery (2.55-Ah, 55-Wh)	537627-001
3-cell lithium-polymer (Li-Pol) battery (2.55-Ah, 28-Wh)	537626-001

Before disassembling the device, follow these steps:

- 1. Shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the device.
- 3. Disconnect the power from the device by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the device.

Remove the battery:

- 1. Turn the device upside-down on a flat surface, with the battery bay toward you.
- 2. Slide the battery release latches (1) to release the battery.
- **3.** Remove the battery **(2)**.



Reverse this procedure to install a battery.

SIM

NOTE: This section applies only to device models with WWAN capability.

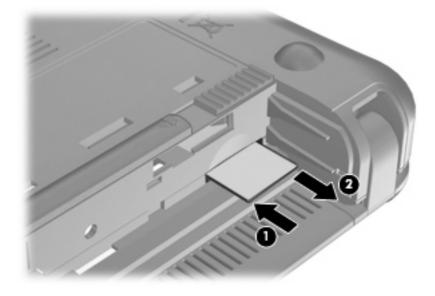
NOTE: If there is a SIM inserted in the SIM slot, it must be removed before disassembling the computer. Be sure that the SIM is reinserted in the SIM slot after reassembling the computer.

Before removing the SIM, follow these steps:

- 1. Shut down the computer. If you are unsure whether the computer is off or in Hibernation, turn the computer on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the computer.
- 3. Disconnect the power from the computer by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the computer.
- 4. Remove the battery (see <u>Battery on page 36</u>).

Remove the SIM:

- 1. Press in on the SIM (1). (The module is partially ejected from the SIM slot.)
- 2. Remove the SIM (2) from the SIM slot.



Reverse this procedure to insert the SIM.

Memory module

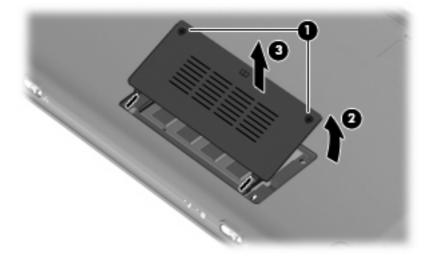
Description	Spare part number
Memory module (PC2-5300, 533-MHz, DDR2)	
512-MB (for use in HP Mini 110 and Compaq Mini 110 only)	537663-001
1024-MB	537664-001
2048-MB (for use in HP Mini 1101 NoteBook PC, and HP Mini 110 with Mobile Mi installed only)	537665-001

Before removing the memory module, follow these steps:

- 1. Shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the device.
- 3. Disconnect the power from the device by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the device.
- 4. Remove the battery (see <u>Battery on page 36</u>).
- 5. If your device has WWAN capability, remove the SIM (see <u>SIM on page 37</u>.

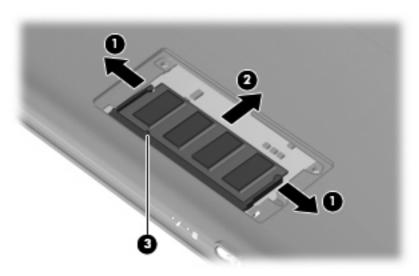
Remove the memory module:

- 1. Loosen the 2 Phillips 2.0×3.0 captive screws (1) that secure the memory module compartment cover to the computer.
- 2. Swing the cover up and away from the inside of the computer (2), and then remove the cover (3).



3. Spread the retaining tabs (1) on each side of the memory module slot to release the memory module. (The edge of the module opposite the slot rises away from the device.)

- 4. Remove the memory module (2) by pulling the module away from the slot at an angle.
- NOTE: Memory modules are designed with a notch (3) to prevent incorrect insertion into the memory module slot.



Reverse this procedure to install a memory module.

Keyboard

De	escription	Spare part number
Fo	r use only on models with Windows operating system installed	
•	For use only in Brazil	535689-201
•	For use only in the Czech Republic	535689-221
•	For use only in Europe	535689-021
•	For use only in Finland, Norway, and Sweden	535689-DH1
•	For use only in France	535689-051
•	For use only in French Canada	535689-121
•	For use only in Germany	535689-041
•	For use only in Greece	535689-151
•	For use only in Hungary	535689-211
•	For use on international models	535689-B31
•	For use only in Israel	535689-BB1
•	For use only in Italy	535689-061
•	For use only in Japan	535689-291
•	For use only in Latin America	535689-161
•	For use only in Portugal	535689-131
•	For use only in Russia	535689-251
•	For use only in Saudi Arabia	535689-171
•	For use only South Korea	535689-AD1
•	For use only in Spain	535689-071
•	For use only in Switzerland	535689-111
•	For use only in Taiwan	535689-AB1
•	For use only in Thailand	535689-281
•	For use only in Turkey	535689-141
•	For use only in the United Kingdom	535689-031
•	For use only in the United States	535689-001
Fo	r use only on models with Mobile Mi installed	
•	For use only in Brazil	535690-201
•	For use only in French Canada	535690-121
•	For use only in Japan	535690-291
•	For use only in Latin America	535690-161
•	For use only in South Korea	535690-AD1
•	For use only in Taiwan	535690-AB1

Description	Spare part number
For use only in Thailand	535690-281
For use only in the United States	535690-001

Before removing the keyboard, follow these steps:

- 1. Shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the device.
- 3. Disconnect the power from the device by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the device.
- 4. Remove the battery (see <u>Battery on page 36</u>).
- 5. If your device has WWAN capability, remove the SIM (see <u>SIM on page 37</u>.

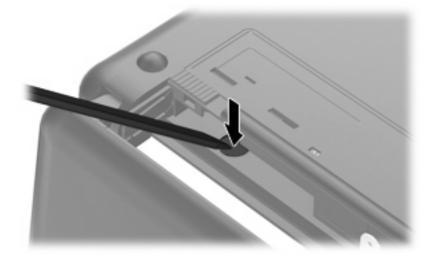
Remove the keyboard:

1. Remove the 3 Phillips SP2.0×3.0 screws that secure the keyboard to the device.



- 2. Turn the device right-side up, and then open the display as far as possible.
- 3. Turn the device upside down, and locate the keyboard release access on the bottom of the computer, inside the battery bay.

4. Insert a flexible tool into the opening, and then press inward to release the keyboard.



- 5. Turn the device right-side up, and then lift up on the top and left edges (1) of the keyboard until the keyboard releases completely.
- 6. Slide the keyboard back until its top edge rests on the display assembly (2).



7. Release the zero insertion force (ZIF) connector (1) to which the keyboard cable is attached.

8. Disconnect the cable (2), and then remove the keyboard.



9. Remove the keyboard.

Reverse this procedure to install the keyboard.

RTC battery

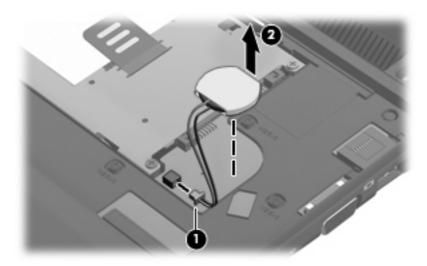
Description	Spare part number
RTC battery	537616-001

Before removing the real-time clock (RTC) battery, follow these steps:

- 1. Shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the device.
- **3.** Disconnect the power from the device by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the device.
- 4. Remove the battery (see <u>Battery on page 36</u>).
- 5. If your device has WWAN capability, remove the SIM (see <u>SIM on page 37</u>.
- 6. Remove the Keyboard (see Keyboard on page 40)

Remove the RTC battery:

- **1**. Disconnect the RTC battery cable **(1)** from the system board.
- 2. Detach the RTC battery (2) from the system board.
- **NOTE:** The RTC battery is attached to the system board with double-sided tape.



Reverse this procedure to install the RTC battery.

Mass storage devices

NOTE: Each hard drive spare part kit and solid-state drive spare part kit includes a cable and bracket.

Description	Spare part number
Hard drive (select models only)	
250-GB, 5400-RPM	537635-001
160-GB, 5400-RPM	537634-001
Hard Drive Hardware Kit	537641-001
Solid-state drive	
64-GB	537640-001
32-GB	537639-001
16-GB	537638-001
8-GB	537637-001
Solid-state Drive Hardware Kit	537642-001

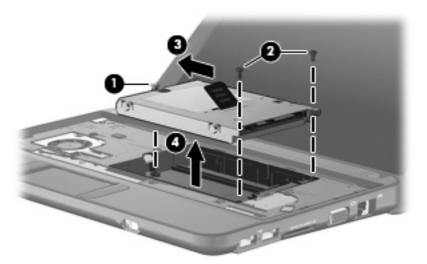
Before removing the hard drive or solid-state drive, follow these steps:

- 1. Shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the device.
- 3. Disconnect the power from the device by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the device.
- 4. Remove the battery (see <u>Battery on page 36</u>).
- 5. If your device has WWAN capability, remove the SIM (see <u>SIM on page 37</u>.
- 6. Remove the keyboard (see Keyboard on page 40).

To remove the mass storage assembly:

Loosen the Phillips SP2.5×10.0 captive screw (1), and remove the two Phillips PM2.0×5.0 screws (2) that secure the assembly to the device.

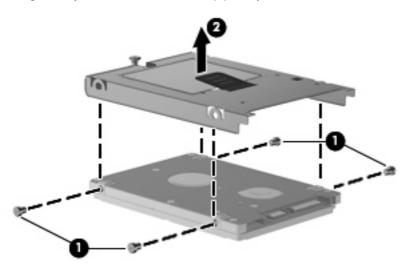
2. Use the Mylar tab to slide the assembly to the left (3) to disconnect it, and remove the assembly (4).



Continue with one of the following sections for hard drive or solid-state drive replacement.

Hard drive

- 1. Remove the 4 Phillips SP3.0×4.0 screws (1) that secure the hard drive bracket to the hard drive.
- 2. Using the Mylar tab, lift the bracket (2) away from the hard drive.

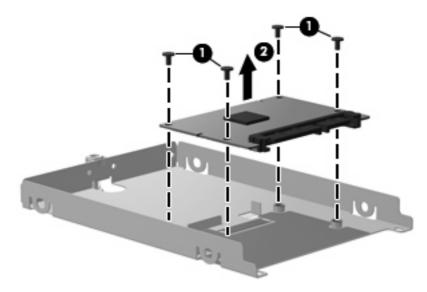


Reverse this procedure to install a hard drive.

Solid-state drive

To remove the solid-state drive:

1. Remove the 4 Phillips SP2.0×3.0 screws (1) that secure the solid-state drive bracket to the solidstate drive. 2. Lift the solid-state drive (2) to remove it.



Reverse this procedure to install a solid-state drive.

Top cover

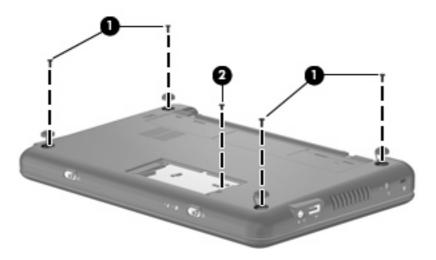
Description	Spare part number
Top cover (includes TouchPad)	537622-001

Before removing the top cover, follow these steps:

- 1. Shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the device.
- 3. Disconnect the power from the device by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the device.
- 4. Remove the battery (see <u>Battery on page 36</u>).
- 5. If your device has WWAN capability, remove the SIM (see <u>SIM on page 37</u>.
- 6. Remove the memory module (see <u>Memory module on page 38</u>
- 7. Remove the keyboard (see <u>Keyboard on page 40</u>).
- 8. Remove the hard drive or solid-state drive assembly (see Mass storage devices on page 45).

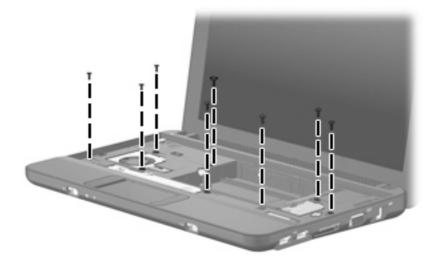
Remove the top cover.

- 1. Turn the device upside down, with the front toward you.
- 2. Use a thin, flat tool to release the 4 tethered rubber feet.
- 3. Remove the four Phillips PM2.5×7.0 screws (1), and the Phillips SP2.0×5.0 screw (2) that secure the top cover to the base enclosure.



- 4. Turn the device right-side up, with the front toward you.
- 5. Open the device as far as possible.

6. Remove the 8 Phillips PM2.5×7.0 screws that secure the top cover to the base enclosure.

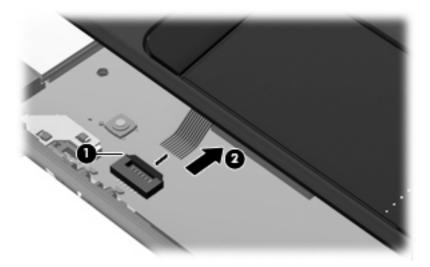


7. Lift the inside edge of the top cover (1) and swing it up. Then slide the top cover back slightly to rest against the display assembly (2) at an angle.



8. Release the ZIF connector (1) to which the TouchPad button board cable is connected.

9. Disconnect the TouchPad button board cable (2) from the system board, and then remove the top cover.



Reverse this procedure to install the top cover.

WLAN module

Description	Spare part number
Broadcom 4312 802.11/b/g WLAN module	
For use in Canada, the Cayman Islands, Guam, Puerto Rico, the U.S. Virgin Islands, and the United States	504593-003
For use in Afghanistan, Albania, Algeria, Andorra, Angola, Antigua and Barbuda, Argentina, Armenia, Aruba, Australia, Austria, Azerbaijan, the Bahamas, Bahrain, Bangladesh, Barbados, Belarus, Belgium, Belize, Benin, Bermuda, Bhutan, Bolivia, Bosnia and Herzegovina, Botswana, Brazil, the British Virgin Islands, Brunei, Bulgaria, Burkina Faso, Burundi, Cameroon, Cape Verde, the Central African Republic, Chad, Chile, the People's Republic of China, Colombia, Comoros, the Congo, Costa Rica, Croatia, Cyprus, the Czech Republic, Denmark, Djibouti, Dominica, the Dominican Republic, East Timor, Ecuador, Egypt, El Salvador, Equatorial Guinea, Eritrea, Estonia, Ethiopia, Fiji, Finland, France, French Guiana, Gabon, Gambia, Georgia, Germany, Ghana, Gibraltar, Greece, Grenada, Guadeloupe, Guatemala, Guinea, Italy, the Ivory Coast, Jamaica, Jordan, Kazakhstan, Kenya, Kiribati, Kyrgyzstan, Laos, Latvia, Lebanon, Lesotho, Liberia, Liechtenstein, Lithuania, Luxembourg, Macedonia, Madagascar, Malawi, Malaysia, the Maldives, Mali, Malta, the Marshall Islands, Martinique, Nauritania, Nauru, Nepal, the Nether Antilles, the Netherlands, New Zealand, Nicaragua, Niger, Nigeria, Norway, Oman, Pakistan, Palau, Panama, Papua New Guinea, Paraguay, Peru, the Philippines, Poland, Portugal, the Republic of Moldova, Romania, Russia, Rwanda, Samoa, San Marino, Sao Tome and Principe, Saudi Arabia, Senegal, Serbia, the Seychelles, Sierra Leone, Singapore, Slovakia, Slovenia, the Solomon Islands, Somalia, South Africa, South Korea, Spain, Sri Lanka, St. Kitts and Nevis, St. Lucia, St. Vincent and the Grenadines, Suriname, Swaziland, Sweden, Switzerland, Taiwan, Tajikistan, Tanzania, Togo, Tonga, Trinidad and Tobago, Tunisia, Turkey, Turkmenistan, Tuvalu, Uganda, Ukraine, the United Arab Emirates, the United Kingdom, Uruguay, Uzbekistan, Vanuatu, Venezuela, Vietnam, Yemen, Zaire, Zambia, and Zimbabwe	504593-004

\triangle CAUTION: The WWAN module and the WLAN module are not interchangeable.

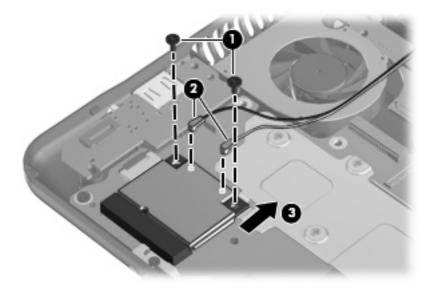
To prevent an unresponsive system, replace the wireless module only with a wireless module authorized for use in the device by the governmental agency that regulates wireless devices in your country or region. If you replace the module and then receive a warning message, remove the module to restore device functionality, and then contact technical support through Help and Support.

Before removing the WLAN module, follow these steps:

- 1. Shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the device.
- 3. Disconnect the power from the device by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the device.
- 4. Remove the battery (see <u>Battery on page 36</u>).
- 5. If your device has WWAN capability, remove the SIM (see <u>SIM on page 37</u>.
- 6. Remove the following components:
 - a. Keyboard (see Keyboard on page 40)
 - **b.** Hard drive or solid-state drive (see <u>Mass storage devices on page 45</u>)
 - **c.** Top cover (see <u>Top cover on page 48</u>)

Remove the WLAN module:

- 1. Remove the 2 Phillips PM2.0×4.0 screws (1) that secure the WLAN module to the system board. (The edge of the module opposite the slot rises away from the device.)
- 2. Disconnect the wireless antenna cables (2) from the terminals on the WLAN module.
- 3. Remove the WLAN module (3) by pulling the module away from the slot at an angle.



Reverse this procedure to install the WLAN module.

WWAN module

NOTE: Not available for computers with Mobile Mi installed.

Description	Spare part number	
HP un2400 Mobile Broadband Module (select models only)	483377-002	
HP un2400 Mobile Broadband Module for use only with Verizon Wireless (select models only)	483377-003	
WWAN module for use only in China	571888-001	

\triangle **CAUTION**: The WWAN module and the WLAN module are not interchangeable.

To prevent an unresponsive system, replace the wireless module only with a wireless module authorized for use in the device by the governmental agency that regulates wireless devices in your country or region. If you replace the module and then receive a warning message, remove the module to restore device functionality, and then contact technical support.

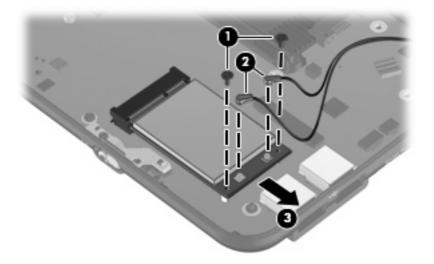
Before removing the WWAN module, follow these steps:

- 1. Shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the device.
- 3. Disconnect the power from the device by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the device.
- 4. Remove the battery (see <u>Battery on page 36</u>).
- 5. Remove the SIM (see <u>SIM on page 37</u>.
- 6. Remove the following components:
 - a. Keyboard (see Keyboard on page 40)
 - b. Hard drive or solid-state drive (see Mass storage devices on page 45)
 - **c.** Top cover (see <u>Top cover on page 48</u>)

Remove the WWAN module:

- 1. Remove the 2 Phillips PM2.0×4.0 screws (1) that secure the WWAN connector module (3) to the system board. (The edge of the module opposite the slot rises away from the device.)
- 2. Disconnect the wireless antenna cables (2) from the terminals on the WWAN module.
- NOTE: The red WWAN antenna cable is connected to the WWAN module "Main" terminal. The blue WWAN antenna cable is connected to the WWAN module "Aux" terminal.

3. Remove the WWAN module (3) by pulling the module away from the slot at an angle.



Reverse this procedure to install the WWAN module.

USB/audio board

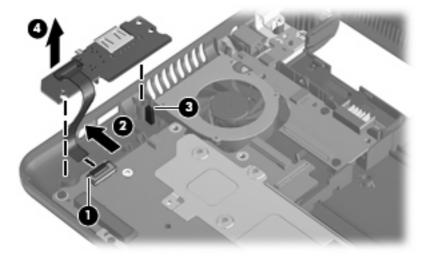
Description	Spare part number
USB/audio board (includes cable)	537614-001

Before removing the USB/audio board, follow these steps:

- 1. Shut down the computer. If you are unsure whether the computer is off or in Hibernation, turn the computer on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the computer.
- 3. Disconnect the power from the computer by first unplugging the power cord from the AC outlet and then unplugging the AC Adapter from the computer.
- 4. Remove the battery (see <u>Battery on page 36</u>).
- 5. If your device has WWAN capability, remove the SIM (see <u>SIM on page 37</u>.
- 6. Remove the following components:
 - **a.** Keyboard (see <u>Keyboard on page 40</u>).
 - b. Hard drive or solid-state drive (see Mass storage devices on page 45).
 - **c.** Top cover (see <u>Top cover on page 48</u>).

Remove the USB board:

- 1. Release the ZIF connector (1) to which the USB/audio board cable is connected, and disconnect the cable (2).
- 2. Release the USB/audio board from the clip attached to the base enclosure (3), and remove the USB/audio board (4).



Reverse this procedure to install the USB/audio board.

Power/battery pass-through board

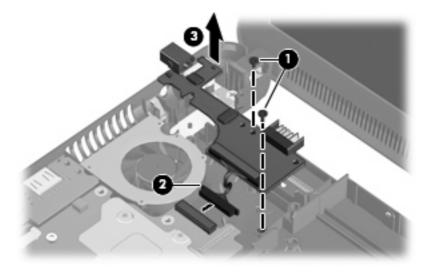
Description	Spare part number
Power/battery passthrough board	537615-001

Before removing the power/battery pass-through board, follow these steps:

- 1. Shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the device.
- 3. Disconnect the power from the device by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the device.
- 4. Remove the battery (see <u>Battery on page 36</u>).
- 5. If your device has WWAN capability, remove the SIM (see <u>SIM on page 37</u>.
- 6. Remove the following components:
 - **a.** Keyboard (see <u>Keyboard on page 40</u>)
 - **b.** Hard drive or solid-state drive (see <u>Mass storage devices on page 45</u>)
 - c. Top cover (see <u>Top cover on page 48</u>)

Remove the power/battery pass-through board:

- 1. Disconnect the power cable (1).
- 2. Remove the 2 Phillips BP2.5×5.0 screws (2) that secure the power/battery passthrough board to the base enclosure.
- 3. Remove the power/battery pass-through board (3).



Reverse this procedure to install the power/battery pass-through board.

DescriptionSpare part numberFan537613-001

NOTE: To properly ventilate the device, allow at least a 7.6-cm (3-inch) clearance on the left side of the device. The device uses an electric fan for ventilation. The fan is controlled by a temperature sensor and is designed to turn on automatically when high temperature conditions exist. These conditions are affected by high external temperatures, system power consumption, power management/battery conservation configurations, battery fast charging, and software requirements. Exhaust air is displaced through the ventilation grill located on the left side of the device.

Before removing the fan, follow these steps:

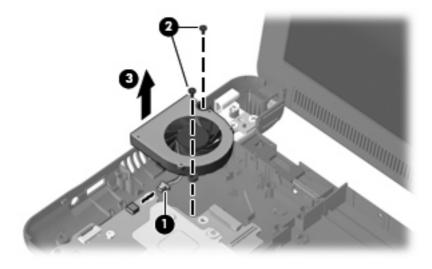
- 1. Shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the device.
- 3. Disconnect the power from the device by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the device.
- 4. Remove the battery (see <u>Battery on page 36</u>).
- 5. If your device has WWAN capability, remove the SIM (see <u>SIM on page 37</u>.
- 6. Remove the following components:
 - a. Keyboard (see Keyboard on page 40)
 - b. Hard drive or solid-state drive (see <u>Mass storage devices on page 45</u>)
 - **c.** Top cover (see <u>Top cover on page 48</u>)

Remove the fan:

Fan

- 1. Disconnect the fan cable (1).
- 2. Remove the 2 Phillips PM2.5×5.0 screws (2) that secure the fan to the base enclosure.

3. Remove the fan (3).



Reverse this procedure to install the fan.

Heat sink assembly

Description	Spare part number
Heat sink assembly (includes replacement thermal material)	537619-001

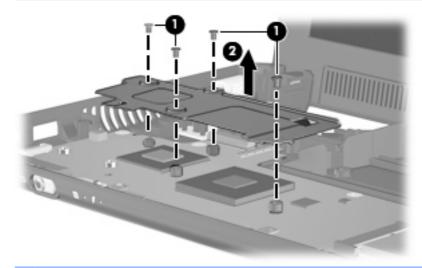
Before removing the heat sink assembly, follow these steps:

- 1. Shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the device.
- 3. Disconnect the power from the device by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the device.
- 4. Remove the battery (see <u>Battery on page 36</u>).
- 5. If your device has WWAN capability, remove the SIM (see <u>SIM on page 37</u>.
- 6. Remove the following components:
 - **a.** Keyboard (see <u>Keyboard on page 40</u>)
 - b. Hard drive or solid-state drive (see Mass storage devices on page 45)
 - c. Top cover (see <u>Top cover on page 48</u>)
 - d. WLAN module (see <u>WLAN module on page 51</u>)
 - e. Fan (see <u>Fan on page 57</u>)

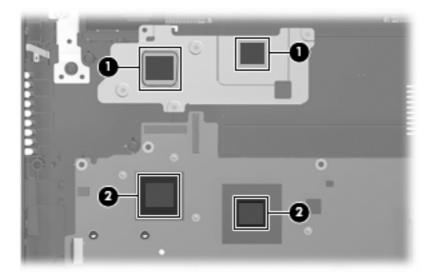
Remove the heat sink assembly:

- 1. Remove the 4 Phillips SP1.5×1.05 screws (1) that secure the heat sink assembly to the system board.
 - **NOTE:** The screws are numbered 1 through 4. Follow this order when removing the screws.

- 2. Remove the heat sink assembly (2).
- NOTE: Due to the adhesive quality of the thermal material located between the heat sink assembly and system board components, it may be necessary to move the heat sink assembly from side to side to detach the assembly.



NOTE: The thermal material must be thoroughly cleaned from the surfaces of the heat sink assembly and the system board each time the heat sink assembly is removed. Thermal paste is used on the processor (1), and thermal tape is used on the Northbridge chip (2). Replacement thermal material is included with all heat sink assembly and system board spare part kits.



Reverse this procedure to install the heat sink assembly.

System board

Description	Spare part number
System board (includes processor and replacement thermal material)	
Includes Intel Atom N280 1.66-GHz processor, 512-KB Level 2 cache, 533-MHz front-side bus (FSB)	571370-001
Includes Intel Atom N270 1.6-GHz processor, 512-KB Level 2 cache, 533-MHz front-side bus (FSB)	537662-001

Before removing the system board, follow these steps:

- 1. Shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the device.
- 3. Disconnect the power from the device by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the device.
- 4. Remove the battery (see <u>Battery on page 36</u>).
- 5. If your device has WWAN capability, remove the SIM (see <u>SIM on page 37</u>.
- 6. Remove the following components:
 - a. Keyboard (see Keyboard on page 40)
 - b. Hard drive or solid-state drive (see <u>Mass storage devices on page 45</u>)
 - c. Top cover (see <u>Top cover on page 48</u>)

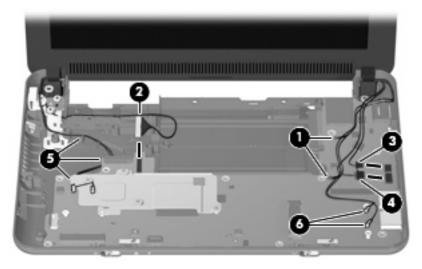
When replacing the system board, be sure that the following components are removed from the defective system board and installed on the replacement system board:

- WLAN module (see <u>WLAN module on page 51</u>)
- WWAN module, if included (see <u>WWAN module on page 53</u>)
- RTC battery (see <u>RTC battery on page 44</u>)
- Heat sink assembly (see <u>Heat sink assembly on page 59</u>)

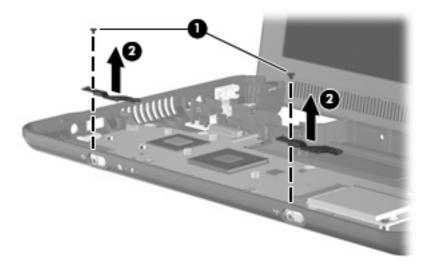
Remove the system board:

1. Release the tape securing the WWAN antennas(1).

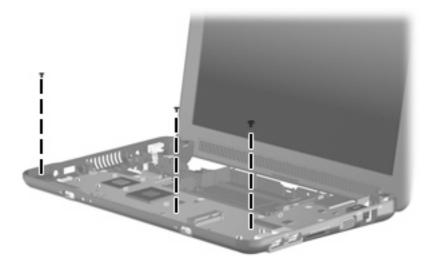
- 2. Disconnect the following cables from the system board:
 - (2) Display panel cable
 - (3) Microphone cable
 - (4) Speaker cable
 - (5) WLAN cables
 - (6) WWAN cables (select models only)



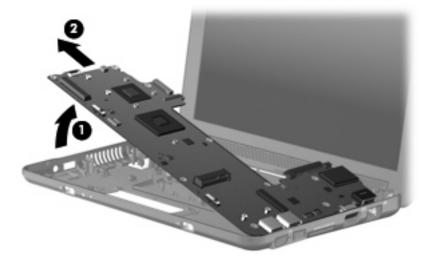
- 3. Remove the 2 Phillips PM1.5×2.0 screws (1) that secure the actuators for the power switch and wireless on/off switch to the system board.
- 4. Remove the actuators (2).



5. Remove the 3 Phillips PM2.5×5.0 screws that secure the system board to the base enclosure.



- 6. Grasp the system board at the midpoint of the left side (1), and lift it up.
- 7. Pull the system board (2) out to the left at an angle to remove it.



8. Remove the system board.

Reverse the procedure to install the system board.

Display assembly

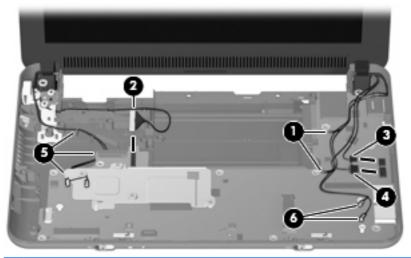
Description	Spare part number
Display assembly (includes 1 webcam, 1 microphone, 1 speaker box, and 2 WLAN antenna transceivers/cables; WWAN is optional)	
See <u>Display assembly components on page 21</u> for a comprehensive list of display assembly spare parts.	
For use with HP models only	
10.1-inch, high-definition, AntiGlare Display Assembly (Includes WWAN)	572407-001
10.1-inch, high-definition, AntiGlare Display Assembly	572406-001
 10.1-inch, standard-definition, AntiGlare Display Assembly (includes WWAN) 	571414-001
10.1-inch, standard-definition, AntiGlare Display Assembly	537646-001
For use with Compaq standard models only	
10.1-inch, high-definition, AntiGlare Display Assembly	572414-001
10.1-inch, standard-definition, AntiGlare Display Assembly (includes WWAN)	571417-001
10.1-inch, standard-definition, AntiGlare Display Assembly	537643-001
Hinge covers	537617-001
Display bezel	
For use with HP Mini 1101 NoteBook PC, and HP Mini 110 only	537650-001
For use with Compaq Mini 110 only	537644-001
Display Hinge Kit	537658-001
(Includes left and right display panel hinges)	
Speaker assembly (includes left and right cables)	537621-001
Display panel	
10.1-inch high-definition AntiGlare	572405-001
10.1-inch standard-definition AntiGlare	537656-001
Webcam module	537660-001
Display Cable Kit (Not illustrated, includes microphone assembly display cable, webcam cable, and WLAN antennas)	537657-001
Display panel cable	
Microphone assembly	
WLAN antennas	
WWAN antennas	537655-001
Display enclosure (includes logo)	
For use with the HP Mini 1101 Notebook PC, and HP Mini 110	537651-001
For use with the Compaq Mini 110	537645-001
Display Screw Kit (not illustrated)	538510-001

Before removing the display assembly, follow these steps:

- 1. Shut down the device. If you are unsure whether the device is off or in Hibernation, turn the device on, and then shut it down through the operating system.
- 2. Disconnect all external devices connected to the device.
- 3. Disconnect the power from the device by first unplugging the power cord from the AC outlet and then unplugging the AC adapter from the device.
- 4. Remove the battery (see <u>Battery on page 36</u>).
- 5. If your device has WWAN capability, remove the SIM (see <u>SIM on page 37</u>.
- 6. Remove the following components:
 - a. Keyboard (see Keyboard on page 40)
 - b. Hard drive or solid-state drive (see Mass storage devices on page 45)
 - c. Top cover (see <u>Top cover on page 48</u>)

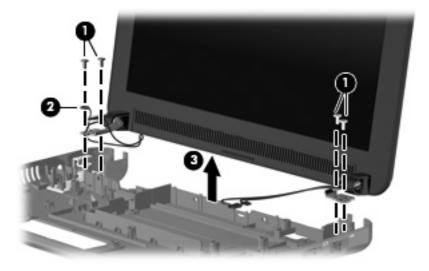
Remove the display assembly:

- 1. Release the tape securing the WWAN antennas(1).
- 2. Disconnect the following cables from the system board:
 - (2) Display panel cable
 - (3) Microphone cable
 - (4) Speaker cable
 - (5) WLAN cables
 - (6) WWAN cables (select models only)

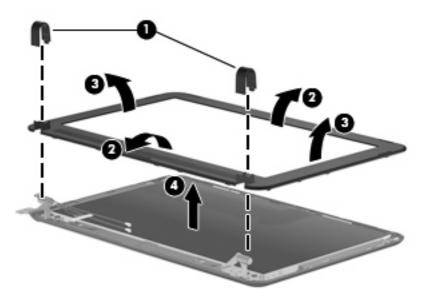


△ CAUTION: Support the display assembly when removing the following screws. Failure to support the display assembly can result in damage to the display assembly and other device components.

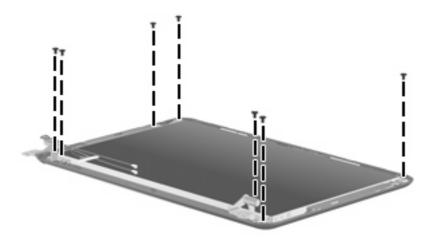
- 3. Remove the 4 Phillips PM2.5×5.0 screws (1) that secure the display assembly to the device.
- **NOTE:** One screw on the left hinge (2) also secures the display panel cable ground strap.



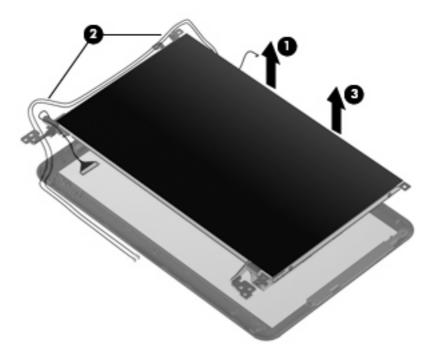
- 4. Remove the display assembly.
- 5. If it is necessary to replace the display bezel, perform the following steps:
 - **a.** Remove the display hinge covers (1).
 - **b.** Flex the inside edges of the top and bottom (2), and then the left and right sides (3) of the display bezel until the bezel disengages from the display enclosure.
 - c. Remove the display bezel (4).



- 6. If it is necessary to replace the display panel, perform the following steps:
 - **a.** Remove the 7 Phillips PM2.0×3.0 screws that secure the display panel to the display enclosure.

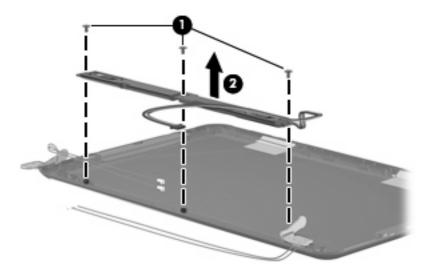


- **b.** Lift the display panel up from the display enclosure (1).
- c. Disconnect the webcam cable (2) from the system board (2)
- d. Remove the display panel (3) from the display enclosure.

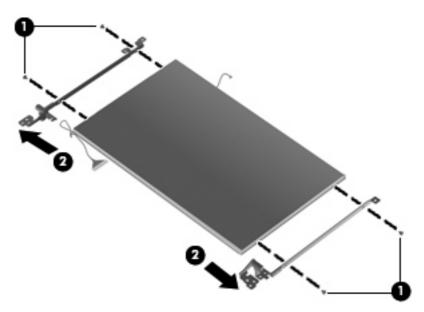


- 7. If it is necessary to replace the speaker assembly, perform the following steps:
 - **a.** Remove the three Phillips PM2.0×3.0 screws (1) that secure the speaker assembly to the display enclosure.

b. Remove the speaker assembly (2).

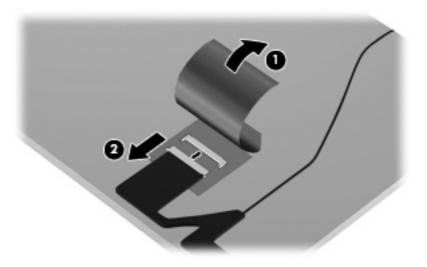


- 8. If it is necessary to replace the display hinges, perform the following steps:
 - **a.** Remove the 2 Phillips PM2.0×3.0 screws (1) that secure each hinge to the display enclosure.
 - b. Remove the hinges (2).

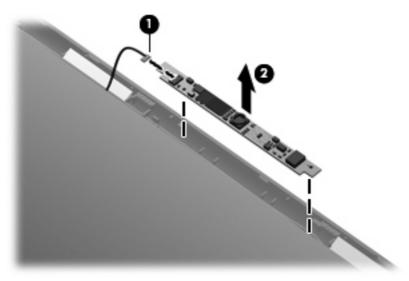


- 9. If it is necessary to replace the display panel cable, perform the following steps:
 - **a.** Peel back the Mylar protection on the back of the display panel (1).

b. Disconnect the display panel cable (2).

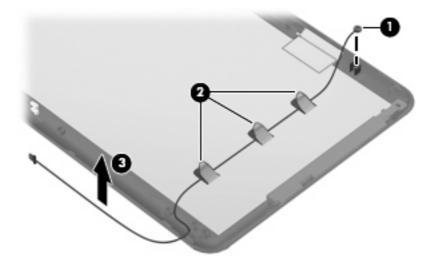


- **10.** If it is necessary to replace the webcam module, perform the following steps:
 - a. Disconnect the webcam cable (1) from the webcam.
 - **b.** Remove the webcam (2).

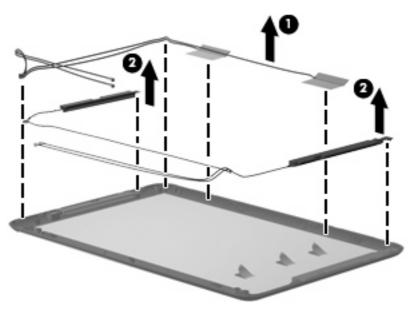


- **11.** If it is necessary to replace the microphone receiver, perform the following steps:
 - a. Release the microphone receiver from the clip (1) that secures it to the display enclosure.

b. Pull the receiver through the tabs (2), and remove the microphone receiver (3).



12. If it is necessary to replace the wireless antenna transceivers and cables, detach the cables from the adhesive (1) that secures them to the display enclosure, and then remove the cables (2).



Reverse this procedure to reassemble and install the display assembly.

5 Setup Utility

Starting the Setup Utility

The Setup Utility is a ROM-based information and customization utility that can be used even when your operating system is not working.

The utility reports information about the device and provides settings for startup, security, and other preferences.

To start the Setup Utility:

Open the Setup Utility by turning on or restarting the device, and then pressing f10 while the "F10 = BIOS Setup Options" message is displayed in the lower-left corner of the screen.

Using the Setup Utility

Changing the language of the Setup Utility

The following procedure explains how to change the language of the Setup Utility. If the Setup Utility is not already running, begin at step 1. If the Setup Utility is already running, begin at step 2.

- Open the Setup Utility by turning on or restarting the device, and then pressing f10 while the "F10 = BIOS Setup Options" message is displayed in the lower-left corner of the screen.
- 2. Use the arrow keys to select **System Configuration > Language**, and then press enter.
- 3. Use the arrow keys to select a language, and then press enter.
- 4. When a confirmation prompt with your language selected is displayed, press enter.
- To save your change and exit the Setup Utility, use the arrow keys to select Exit > Exit Saving Changes, and then press enter.

Your change goes into effect immediately.

Navigating and selecting in the Setup Utility

Because the Setup Utility is not operating system–based, it does not support the TouchPad. Navigation and selection are by keystroke.

- To choose a menu or a menu item, use the arrow keys.
- To choose an item in a list or to toggle a field, for example an Enable/Disable field, use either the arrow keys or f5 or f6.

- To select an item, press enter.
- To close a text box or return to the menu display, press esc.
- To display additional navigation and selection information while the Setup Utility is open, press f1.

Displaying system information

The following procedure explains how to display system information in the Setup Utility. If the Setup Utility is not open, begin at step 1. If the Setup Utility is open, begin at step 2.

- Open the Setup Utility by turning on or restarting the device, and then pressing f10 while the "F10 = BIOS Setup Options" message is displayed in the lower-left corner of the screen.
- 2. Select the **Main** menu. System information such as the system time and date, and identification information about the device is displayed.
- To exit the Setup Utility without changing any settings, use the arrow keys to select Exit > Exit Discarding Changes, and then press enter.

Restoring default settings in the Setup Utility

The following procedure explains how to restore the Setup Utility default settings. If the Setup Utility is not already running, begin at step 1. If the Setup Utility is already running, begin at step 2.

- Open the Setup Utility by turning on or restarting the device, and then pressing f10 while the "F10 = BIOS Setup Options" message is displayed in the lower-left corner of the screen.
- 2. Use the arrow keys to select **Exit > Load Setup Defaults**, and then press enter.
- 3. When the Setup Confirmation is displayed, press enter.
- 4. To save your change and exit the Setup Utility, use the arrow keys to select **Exit > Exit Saving Changes**, and then press enter.

The Setup Utility default settings go into effect when the device restarts.

NOTE: Your password, security, and language settings are not changed when you restore the factory default settings.

Exiting the Setup Utility

You can exit the Setup Utility with or without saving changes.

• To exit the Setup Utility and save your changes from the current session:

If the Setup Utility menus are not visible, press esc to return to the menu display. Then use the arrow keys to select **Exit > Exit Saving Changes**, and then press enter.

• To exit the Setup Utility without saving your changes from the current session:

If the Setup Utility menus are not visible, press esc to return to the menu display. Then use the arrow keys to select **Exit > Exit Discarding Changes**, and then press enter.

After either choice, the device restarts and loads the operating system.

Setup Utility menus

The menu tables in this section provide an overview of Setup Utility options.

NOTE: Some of the Setup Utility menu items listed in this chapter may not be supported by your device.

Main menu

Select	To do this
System information	 View and change the system time and date. View identification information about the device. View specification information about the processor, memory size,
	and system BIOS.

Security menu

Select	To do this
Administrator password	Enter, change, or delete an administrator password.
Power-On Password	Enter, change, or delete a power-on password.

System Configuration menu

Select	To do this	
Language Support	Change the Setup Utility language.	
Processor C4 State	Enable/disable the processor C4 sleep state.	
Boot Options	Set the following boot options:	
	• f10 and f12 Delay (sec.)—Set the delay for the f10 and f12 functions of the Setup Utility in intervals of 5 seconds each (0, 5, 10, 15, 20).	
	 Internal Network Adapter boot—Enable/disable boot from Internal Network Adapter. 	
	Boot Order—Set the boot order for:	
	 Internal hard drive (select models only) 	
	• USB Floppy	
	• USB CD/DVD ROM Drive	
	• USB flash drive	
	• USB Hard drive	
	• USB Card Reader	
	Network adapter	
	NOTE: Only the devices attached to the system will appear in the boot order menu.	

Diagnostics menu

Select	To do this
Hard Disk Self Test (select models only)	Run a comprehensive self-test on the hard drive.
Memory Test	Run a diagnostic test on the system memory.

6 Specifications

Device specifications

	Metric	U.S.
Dimensions		
Depth	16.67 cm	6.56 in
Width	26.17 cm	10.30 in
Height	2.52 cm	0.99 in
Weight		
10.1-in. LCD, equipped with a 3-cell battery, hard drive, 1-GB memory, WLAN module, and 2 wireless antennas	1.11 kg	2.45 lb
10.1-in. LCD, equipped with a 3-cell battery,solid-state drive, 1-GB memory, WLAN module, and 2 wireless antennas	1.09 kg	2.40 lb
Input power		
Operating voltage	19 V dc @ 1.58 A – 30 W	
Operating current	1.58 A	
Temperature		
Operating	5°C to 35°C	41°F to 95°F
Nonoperating	-20°C to 65°C	-4°F to 149°F
Relative humidity (noncondensing)		
Operating	10% to 90%	
Nonoperating	0% to 95%	
Maximum altitude (unpressurized)		
Operating	-15 m to 3,048 m	-50 ft to 10,000 ft
Nonoperating	-15 m to 12,192 m	-50 ft to 40,000 ft

NOTE: Applicable product safety standards specify thermal limits for plastic surfaces. The device operates well within this range of temperatures.

10.1-inch, AntiGlare display specifications

	Metric	U.S.
Dimensions		
Height	23.45 cm	9.23 in
Width	14.30 cm	5.62 in
Diagonal	25.55 cm	10.05 in
Number of colors	262,144	
Contrast ratio	400:1 (typical)	
Brightness	200 nits (typical)	
Pixel resolution		
Pitch	0.2175 × 0.2175 mm	
Format	1024 × 576	
Configuration	RGB vertical stripe	
Backlight	Edge lit	
Character display	80 × 25	
Total power consumption	3.2 W	
Viewing angle	+/-45° horizontal, +15/-35° ver	tical (typical)

Hard drive specifications

	60-GB *
Dimensions	
Height	9.5 mm
Width	70 mm
Weight	101 g
Interface type	ΡΑΤΑ
Transfer rate	100 MB/sec
Security	ATA security
Seek times (typical read, including setting)	
Single track	3 ms
Average	13 ms
Maximum	24 ms
Logical blocks	117,210,240
Disc rotational speed	4200 rpm
Operating temperature	

* 1 GB = 1 billion bytes when referring to hard drive storage capacity. Actual accessible capacity is less. Actual drive specifications may differ slightly.

NOTE: Certain restrictions and exclusions apply. Contact technical support for details.

Solid-state drive specifications

Performance	
Transfer modes supported	UDMA 0-4, Multiword-DMA 0-2, PIO 0-4
Sustained read	39 MB/sec
Sustained write	17 MB/sec
Characteristics	
Interface	Parallel ATA (PATA)
MLC NAND flash capacity	8 GB, 16 GB
Electrical specifications	
DC supply voltage	3.3 V +/- 5%
Standby current	300 μA (typical)
Active current	Read = 130 mA (typical)
	Write = 120 mA (typical)
Environmental specifications	
Operating temperature	0°C to +70°C (32°F to 158°F)
Storage temperature	-25°C to +85°C (-13°F to 185°F)
Operating altitude	up to 24,384 m (80,000 feet)
Humidity	5% to 90% non-condensing
Shock	1,000 g
Acoustic noise	0 dB
Vibration	15 g (peak to peak)
Physical specifications	
Connector	40-pin ZIF connector
Weight (8-GB model)	5.5 g
Weight (16-GB model)	7.0 g
Dimensions (8-GB model)	54 × 32 × 2.6 mm
Dimensions (16-GB model)	54 × 32 × 3.75 mm
Regulations and compliance	RoHS, China RoHS, SGS ROHS, FCC, CE UL – PCB Only

System DMA specifications

Hardware DMA	System function
DMA0	Not applicable
DMA1 *	Not applicable
DMA2 *	Not applicable
DMA3	Not applicable
DMA4	Direct memory access controller

System interrupt specifications

Hardware IRQ	System function
IRQ0	System timer
IRQ1	Standard 101-/102-Key or Microsoft® Natural PS/2 Keyboard
IRQ8	System CMOS/real-time clock
IRQ9 *	Microsoft ACPI-compliant system
IRQ12	Synaptics PS/2 TouchPad
IRQ13	Numeric data processor
IRQ14	Primary IDE channel
IRQ15	Intel® 82801G (ICH7 Family) SMBus Controller—27DA
IRQ16	Broadcom 802.11b/g WLAN no. 2
	Intel 82801G (ICH7 Family) PCI Express Root Port—27D0
	Intel 82801G (ICH7 Family) USB Universal Host Controller—27CB
	Microsoft UAA Bus Driver for High Definition Audio
	Mobile Intel 945 Express Chipset Family
IRQ17	Intel 82801G (ICH7 Family) PCI Express Root Port—27D2
IRQ18	Intel 82801G (ICH7 Family) USB Universal Host Controller—27CA
IRQ19	Intel 82801G (ICH7 Family) USB Universal Host Controller—27C9
IRQ23	Intel 82801G (ICH7 Family) USB Universal Host Controller—27C8
	Intel 82801G (ICH7 Family) USB2 Enhanced Host Controller—27CC
* Default configuration	

* Default configuration

System I/O address specifications

I/O address (hex)	System function (shipping configuration)
000 - 00F	DMA controller
000 - CF7	PCI bus
010 - 01F	Motherboard resources
020 - 021	Programmable interrupt controller
022 - 03F	Motherboard resources
040 - 043	System timer
044 - 05F	Motherboard resources
060 - 060	Standard 101-/102-Key or Microsoft® Natural PS/2 Keyboard
061 - 061	System speaker
062 - 062	Microsoft ACPI-Compliant Embedded Controller
063- 063	Motherboard resources
064 - 064	Standard 101-/102-Key or Microsoft Natural PS/2 Keyboard
065 - 065	Motherboard resources
066 - 066	Microsoft ACPI-Compliant Embedded Controller
067 - 06F	Motherboard resources
070 - 071	System CMOS/real-time clock
072 - 07F	Motherboard resources
080 - 080	Motherboard resources
081 - 083	DMA controller
084 - 086	Motherboard resources
087 - 087	DMA controller
088 - 088	Motherboard resources
089 - 08B	DMA controller
08C - 08E	Motherboard resources
08F - 08F	DMA controller
090 - 09F	Motherboard resources
0A0 - 0A1	Programmable interrupt controller
0A2 - 0BF	Motherboard resources
0C0 - 0DF	DMA controller
0E0 - 0EF	Motherboard resources
0F0 - 0FF	Numeric data processor
1F0 - 1F7	Primary IDE channel
274 - 277	ISAPNP Read Data Port

I/O address (hex)	System function (shipping configuration)
279 - 279	ISAPNP Read Data Port
3B0 - 3BB	Mobile Intel® 945 Express Chipset Family
3C0 - 3DF	Mobile Intel 945 Express Chipset Family
3F6 - 3F6	Primary IDE channel
400 - 41F	Intel 82801G (ICH7 Family) SMBus Controller—27DA
480 - 4BF	Motherboard resources
4D0 - 4D1	Motherboard resources
500 - 501	Motherboard resources
800 - 87F	Motherboard resources
A79 - A79	ISAPNP Read Data Port
0D00 - FFFF	PCI bus
D480 - D49F	Intel 82801G (ICH7 Family) USB Universal Host Controller—27C8
D800 - D81F	Intel 82801G (ICH7 Family) USB Universal Host Controller—27CA
D880 - D89F	Intel 82801G (ICH7 Family) USB Universal Host Controller—27C9
DC00 - DC1F	Intel 82801G (ICH7 Family) USB Universal Host Controller—27C8
DC80 - DC87	Mobile Intel 945 Express Chipset Family
E000 - EFFF	Intel 82801G (ICH7 Family) PCI Express Root Port—27D2
FFA0 - FFAF	Intel 82801G (ICH7 Family) Ultra ATA Storage Controllers—27DF

System memory map specifications

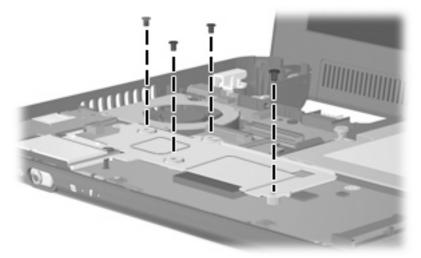
Memory address	System function
00000000 - 0009FFFF	System board
000A0000 - 000BFFFF	Mobile Intel® 945 Express Chipset Family
000A0000 - 000BFFFF	PCI bus
000C0000 - 000CFFFF	System board
000D0000 - 000DFFFF	PCI bus
000E0000 - 000FFFFF	System board
00100000 - 3F7FFFFF	System board
3F800000 - DFFFFFF	PCI bus
D0000000 - DFFFFFF	Mobile Intel 945 Express Chipset Family
E0000000 - E3FFFFF	Motherboard resources
E4000000 - FED8FFFF	PCI bus
FE880000 - FE8FFFFF	Mobile Intel 945 Express Chipset Family
FE937C00 - FE937FFF	Intel 82801G (ICH7 Family) USB2 Enhanced Host Controller—27CC
FE938000 - FE93BFFF	Microsoft® UAA Bus Driver for High Definition Audio
FE940000 - FE97FFFF	Mobile Intel 945 Express Chipset Family
FE980000 - FE9FFFFF	Mobile Intel 945 Express Chipset Family
FEA00000 - FEAFFFFF	Intel 82801G (ICH7 Family) PCI Express Root Port—27D0
FEAFC000 - FEAFFFFF	Broadcom 802.11b/g WLAN
FEB00000 - FEBFFFFF	Intel 82801G (ICH7 Family) PCI Express Root Port—27D2
FEC00000 - FEC00FFF	Motherboard resources
FED13000 - FED19FFF	System board
FED1C000 - FED1FFFF	Motherboard resources
FED20000 - FED3FFFF	Motherboard resources
FED40000 - FED8FFFF	Motherboard resources
FED90000 - FFFFFFF	System board
FEE00000 - FEE00FFF	Motherboard resources

7 Screw listing

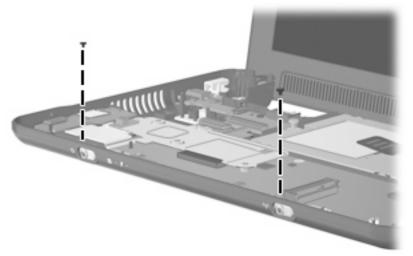
This section provides specification and reference information for the screws and screw locks used in the device. All screws listed in this section are available in the Screw Kit, spare part number 537620-001; or in the Display Screw Kit, spare part number 538510-001.

Phillips PM1.5×1.0 screw

mm	mm luutuutuutuutuut					
Color	Quantity	Length	Thread	Head diameter		
Silver	6	1.0 mm	1.5 mm	1.0 mm		

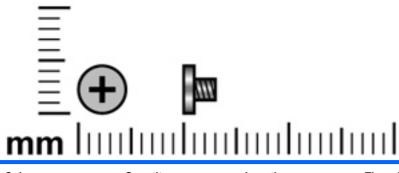


Where used: 4 screws that secure the heat sink to the system board



Where used: Two screws that secure the power and wireless switch actuators to the base enclosure

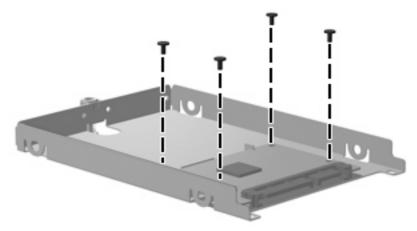
Phillips PM2.0×3.0 screw



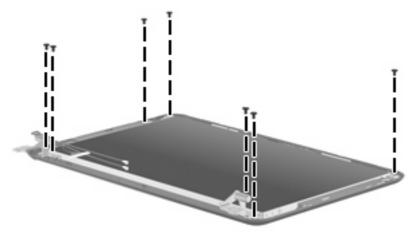
Color	Quantity	Length	Thread	Head diameter
Black	20	3.0 mm	2.0 mm	4.0 mm



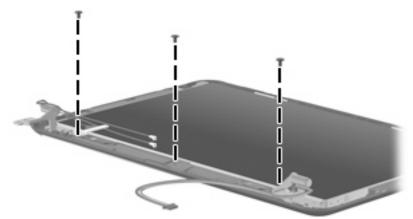
Where used: 3 screws that secure the keyboard to the device



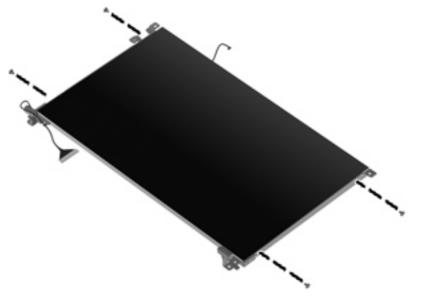
Where used: Four screws that secure the solid-state drive to the bracket



Where used: Seven screws that secure the display panel to the display enclosure

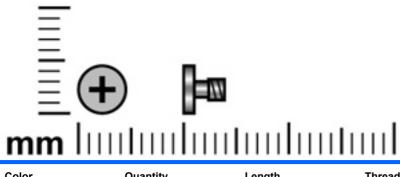


Where used: Three screws that secure the speaker assembly to the display enclosure



Where used: Four screws that secure the hinges to the display panel

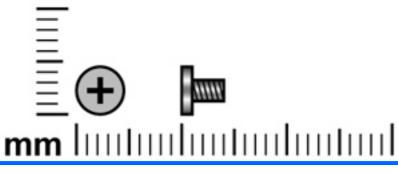
Phillips PM2.0×3.0 captive screw



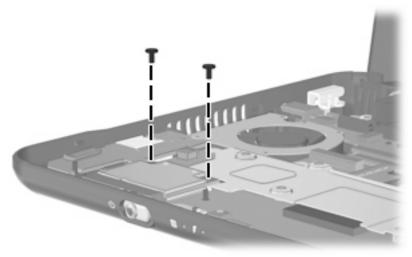
Color	Quantity	Length	Thread	Head diameter
Black	2	3.0 mm	2.0 mm	4.0 mm



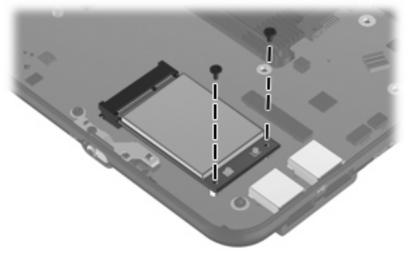
Phillips PM2.0×4.0 screw



Color	Quantity	Length	Thread	Head diameter
Silver	4	4.0 mm	2.0 mm	4.0 mm

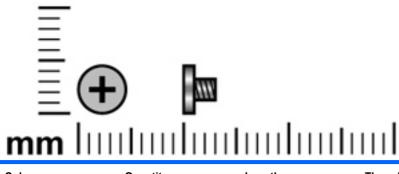


Where used: Two screws that secure the WLAN module to the system board

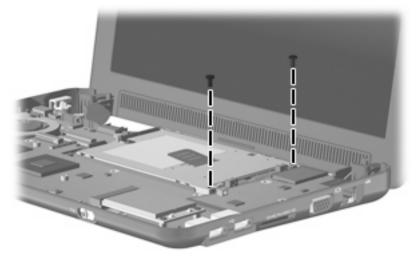


Where used: Two screws that secure the WWAN to the system board

Phillips PM2.0×5.0 screw



Color	Quantity	Length	Thread	Head diameter
Silver	3	5.0 mm	2.0 mm	4.5 mm

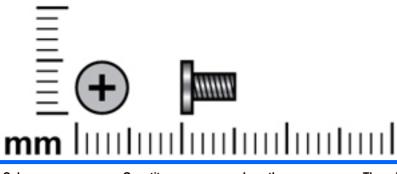


Where used: Two screws that secure the hard drive or solid-state drive to the system board

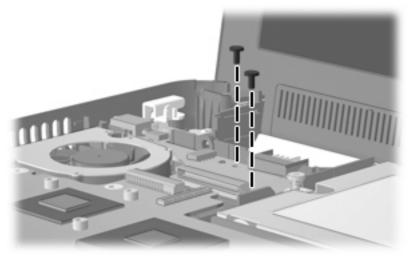


Where used: One screw that secures the top cover to the base enclosure

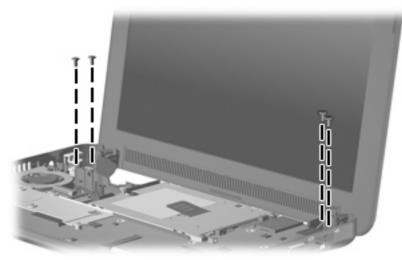
Phillips PM2.5×5.0 screw



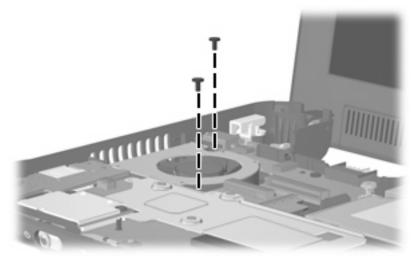
Color	Quantity	Length	Thread	Head diameter
Silver	15	5.0 mm	2.5 mm	4.5 mm



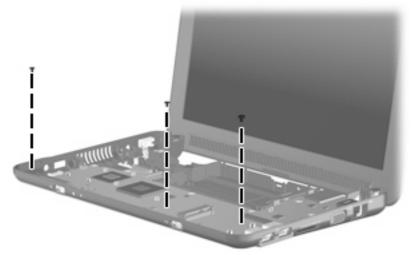
Where used: Two screws that secure the power/battery passthrough board to the system board



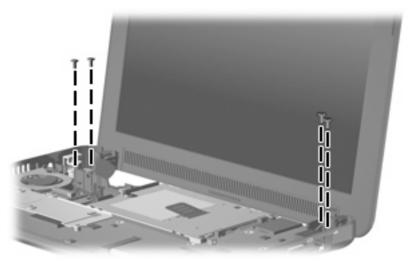
Where used: Four screws that secure the display assembly and top cover to the device



Where used: Two screws that secure the fan to the system board

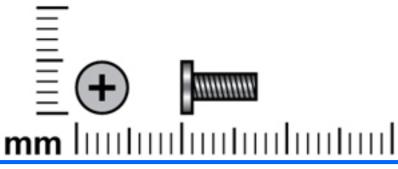


Where used: Three screws that secure the system board to the base enclosure



Where used: Four screws that secure the display assembly to the base enclosure

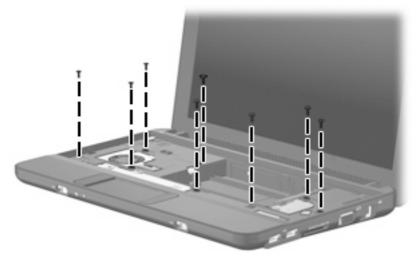
Phillips PM2.5×7.0 screw



Color	Quantity	Length	Thread	Head diameter
Black	12	7.0 mm	2.5 mm	4.0 mm

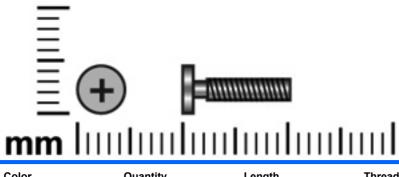


Where used: Four screws that secure the top cover to the base enclosure

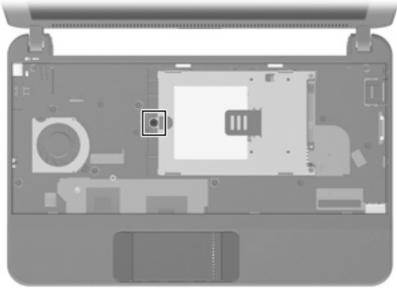


Where used: Eight screws that secure the top cover to the base enclosure

Phillips PM2.5×10.0 captive screw

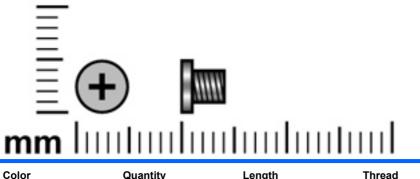


Color	Quantity	Length	Thread	Head diameter
Black	1	10.0 mm	2.5 mm	4.0 mm

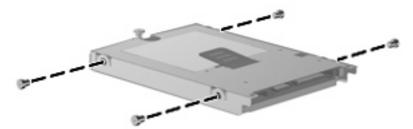


Where used: One captive screw, with a C-clip, that secures the hard drive or solid-state drive bracket to the system board

Phillips PM3.0×40.0 screw



Color	Quantity	Length	Thread	Head diameter
Black	4	4.0 mm	3.0 mm	4.0 mm



Where used: Four screws that secure the hard drive bracket to the hard drive

8 Backup and recovery

Select the section in this chapter that applies to the operating system installed on your computer.

Mobile Mi backup and recovery

Use the instructions in this section if Mobile Mi is installed on your computer.

To protect your information, back up your files and folders. Then if the system fails, you can restore your important files from copies. You can also use the options listed in this section to restore the operating system and programs that were installed at the factory.

Backing up your information

Successful recovery after a system failure depends on whether you have completely backed up your files. You should back up your files on a regular basis to maintain up-to-date files.

You can back up important personal files and folders to the Mini Mobile Drive (select models only), to an external hard drive, or to a USB flash drive (purchased separately).

When to back up

- On a regular basis
- Before the system is repaired or restored
- Before you add or modify hardware or software

Restoring your information

In case of system failure or instability, you can restore the operating system and programs installed at the factory.

△ CAUTION: The restore process reformats hard drive, completely erasing all information. All the files you have created and any software installed on the device are permanently removed. The restore process reinstalls the original operating system, software, and drivers. Software, drivers, and updates not installed with the factory image must be reinstalled using Update Manager.

The device provides the following restore options:

- System Restore (installed on the device): You can use the System Restore utility to restore the original operating system and programs.
- HP Mi Restore Image Creator (USB flash drive): If you are unable to boot (start up) the device, and if you are unable to use System Restore, you can use another computer to download the HP Mi Restore Image Creator utility and create a bootable USB flash drive (purchased separately). You can then use the USB flash drive to install the HP Mi recovery image and programs on your device.

Note the following before beginning the restore process:

- The device must be connected to AC power during the restore process.
- The restore process may take several hours to complete.
- If possible, all personal files should be backed up.

Using System Restore

NOTE: System Restore is the recommended option to restore the original operating system.

To restore the original operating system and programs using the System Restore utility that is installed on the device, follow these steps:

1. Turn on or restart the device, and then press the esc key repeatedly while the "F10 = BIOS Setup Options" message is displayed in the lower-left corner of the screen.

The "System Restore" page opens.

- 2. Use the arrow keys to select **System Restore**, and then press enter.
- 3. Follow the on-screen instructions to restore the system.

Using HP Mi Restore Image Creator

NOTE: Use HP Mi Restore Image Creator if you are unable to boot (start up) the device, and if you are unable to use System Restore.

You will need the following before you begin this restore process:

- A 2-GB (minimum) USB flash drive (purchased separately)
- NOTE: This USB flash drive should have bootable capability. Refer to the USB flash drive manufacturer for additional information.
- An additional computer running either a Windows® or Linux operating system

To perform this restore option, you download the HP Mi Restore Image Creator utility and Mini operating system onto another computer and then transfer the necessary files to the USB flash drive. The drive can then be used to reboot your device and restore the system.

Follow the specific operating system instructions in this section to restore your system.

△ CAUTION: The restore process reformats and completely erases the hard drive on the Mini. All the files you have created and any software installed on the device are permanently removed. The restore process reinstalls the original operating system, software, and drivers. Software, drivers, and updates not installed with the factory image must be reinstalled using Update Manager.

Restoring using a Windows computer

To download the files to a computer running a Windows operating system and then restore your device, follow these steps:

- 1. From your Windows computer, go to <u>http://www.hp.com</u>.
- 2. Click the Support & Drivers tab.
- Under "Step 1: Start by selecting a task," select Download drivers and software (and firmware).
- 4. Under "Step 2: Enter a product name / number," type the part number/product number (p/n) of your Mini, and then click **Go**.
- **NOTE:** The p/n is located on the service tag affixed to the bottom of your Mini.
- 5. Under "Which operating system is used with your product?" click HP Mi or click Linux .

- 6. Click HP Mi Restore Image Creator (for Windows).
- 7. Click **Download only**.
- 8. Save ImageCreator.msi to the Windows computer.
- 9. Double-click **ImageCreator.msi** and follow the on-screen instructions to install HP Mi Restore Image Creator.
- **10.** Insert the USB flash drive into a USB port on the Windows computer.
- \triangle CAUTION: The restore process reformats and completely erases the USB flash drive. All the files on the USB flash drive are permanently removed.
- **11.** Launch **HP Mi Restore Image Creator** from the Start menu.
- 12. Select Download HP Mini recovery image.
- Select the target USB flash drive, and then click Start to download the latest Mini recovery image from the HP Web site.

The recovery image will be downloaded and saved to the Windows computer and then written to the USB flash drive.

- 14. When the download and write processes are complete, remove the USB flash drive.
- 15. Insert the USB flash drive into a USB port on your Mini.
- Change the boot order by turning on or restarting the device, and then pressing f9 repeatedly while the "F9 = Change Boot Device Order" message is displayed in the lower-left corner of the screen.
- **17.** Use the arrow keys to select the USB flash drive, and then press enter.
- **18.** Press enter again to begin restoring the device.
- **19.** Follow the on-screen instructions to install the operating system and programs.
- **20.** After the operating system and programs are installed, remove the USB flash drive.
- NOTE: After the operating system and programs are installed, the device automatically restarts. You are then prompted to set up your device.
- **21.** Use Update Manager to reinstall any updates not installed with the factory image.
- **22.** Restore your personal files.
- NOTE: After this process is complete, you can uninstall the HP Mi Restore Image Creator utility from the Windows computer and delete the downloaded recovery image from the USB flash drive. (The image must be deleted manually.)

Restoring using a Linux computer

To download the files to a computer running a Linux operating system and then restore your device, follow these steps:

- 1. From your Linux computer, go to <u>http://www.hp.com</u>.
- 2. Click the **Support & Drivers** tab.

- 3. Under "Step 1: Start by selecting a task," select **Download drivers and software (and firmware)**.
- 4. Under "Step 2: Enter a product name / number," type the part number/product number (p/n) of your Mini, and then click **Go**.
- NOTE: The p/n is located on the service tag affixed to the bottom of your Mini.
- 5. Under "Which operating system is used with your product?" click HP Mi or click Linux .
- 6. Click HP Mi Restore Image Creator (for Linux).
- 7. Click Download only.
- 8. Save liveusb-creator-ubuntu_0.3.3netbook0dennis5_all.deb to the Linux computer.
- 9. Install liveusb-creator-ubuntu_0.3.3netbook0dennis5_all.deb on the Linux computer.
- **10.** Insert the USB flash drive into a USB port on the Linux computer
- △ CAUTION: The restore process reformats and completely erases the USB flash drive. All the files on the USB flash drive are permanently removed.
- **11.** Open a terminal window and type the following command at the command prompt:

sudo liveusb-creator

- 12. Select Download restore image/HP Mi Restore Image.
- Select the target USB flash drive, and then click Start to download the latest Mini recovery image from the HP Web site.

The recovery image will be downloaded and saved to the Linux computer, and then written to the USB flash drive.

- 14. When the download and write processes are complete, remove the USB flash drive.
- **15.** Insert the USB flash drive into a USB port on your Mini.
- 16. Change the boot order by turning on or restarting the device, and then pressing f9 repeatedly while the "F9 = Change Boot Device Order" message is displayed in the lower-left corner of the screen.
- 17. Use the arrow keys to select the USB flash drive, and then press enter.
- **18.** Press **enter** again to begin restoring the device.
- **19.** Follow the on-screen instructions to install the operating system and programs.
- **20.** After the operating system and programs are installed, remove the USB flash drive.
 - NOTE: After the operating system and programs are installed, the device automatically restarts. You are then prompted to set up your device.
- **21.** Use Update Manager to reinstall any updates not installed with the factory image.
- 22. Restore your personal files.
- NOTE: After this process is complete, you can uninstall the HP Mi Restore Image Creator utility from the Linux computer and delete the downloaded recovery image from the USB flash drive. (The image must be deleted manually.)

Windows Vista backup and recovery

Use the instructions in this section if Windows Vista is installed on your computer.

Backing up your information

Recovery after a system failure is as complete as your most current backup. You should create your initial backup immediately after software setup. As you add new software and data files, you should continue to back up your system on a regular basis to maintain a reasonably current backup.

You can back up your information to an optional external hard drive, a network drive, or discs.

Note the following when backing up:

- Store personal files in the Documents folder, and back it up regularly.
- Back up templates that are stored in their associated programs.
- Save customized settings that appear in a window, toolbar, or menu bar by taking a screen shot of your settings. The screen shot can be a time-saver if you have to reset your preferences.

To create a screen shot:

- 1. Display the screen you want to save.
- 2. Copy the screen image:

To copy only the active window, press alt+fn+prt sc.

To copy the entire screen, press fn+prt sc.

3. Open a word-processing document, and then select Edit > Paste.

The screen image is added to the document.

- 4. Save the document.
- When backing up to discs, use any of the following types of discs (purchased separately): CD-R, CD-RW, DVD+R, DVD+R DL, DVD-R, DVD-R DL, or DVD±RW. The discs you use will depend on the type of optical drive installed in your computer.
 - NOTE: DVDs and DVDs with double-layer (DL) support store more information than CDs, so using them for backup reduces the number of recovery discs required.
- When backing up to discs, number each disc before inserting it into the optical drive of the computer.

To create a backup using Backup and Restore Center, follow these steps:

NOTE: Be sure that the computer is connected to AC power before you start the backup process.

NOTE: The backup process may take over an hour, depending on file size and the speed of the computer.

- 1. Select Start > All Programs > Maintenance > Backup and Restore Center.
- 2. Follow the on-screen instructions to back up your entire computer (select models only) or your files.

NOTE: Windows® includes the User Account Control feature to improve the security of your computer. You may be prompted for your permission or password for tasks such as installing software, running utilities, or changing Windows settings. Refer to Help and Support for more information.

Performing a recovery

In case of system failure or instability, the computer provides the following tools to recover your files:

- Windows recovery tools: You can use the Backup and Restore Center to recover information you have previously backed up. You can also use Windows Startup Repair to fix problems that might prevent Windows from starting correctly.
- f11 recovery tools: You can use the f11 recovery tools to recover your original hard drive image. The image includes the Windows operating system and software programs installed at the factory.
- NOTE: If you are unable to boot (start up) your computer, you must purchase a Windows Vista® operating system DVD to reboot the computer and repair the operating system. For additional information, refer to the "Using a Windows Vista operating system DVD (purchased separately)" section in this guide.

Using the Windows recovery tools

To recover information you previously backed up, follow these steps:

- 1. Click Start > All Programs > Maintenance > Backup and Restore Center.
- 2. Follow the on-screen instructions to recover your entire computer (select models only) or your files.
- NOTE: Windows includes the User Account Control feature to improve the security of your computer. You may be prompted for your permission or password for tasks such as installing software, running utilities, or changing Windows settings. Refer to Help and Support for more information.

To recover your information using Startup Repair, follow these steps:

- △ CAUTION: Using Startup Repair completely erases hard drive contents and reformats the hard drive. All files you have created and any software installed on the computer are permanently removed. When reformatting is complete, the recovery process restores the operating system, as well as the drivers, software, and utilities from the backup used for recovery.
 - 1. If possible, back up all personal files.
 - 2. If possible, check for the presence of the Windows partition and the HP Recovery partition. To find the partitions, select **Start > Computer**.
 - **NOTE:** If the Windows partition and the HP Recovery partition have been deleted, you must recover your operating system and programs using the Windows Vista operating system DVD and the *Driver Recovery* disc (both purchased separately). For additional information, refer to the "Using a Windows Vista operating system DVD (purchased separately)" section in this guide.
 - 3. Restart the computer, and then press f8 before the Windows operating system loads.
 - 4. Select Repair your computer.
 - 5. Follow the on-screen instructions.
- NOTE: For additional information on recovering information using the Windows tools, perform a search for these topics in Help and Support.

Using f11

△ CAUTION: Using f11 completely erases hard drive contents and reformats the hard drive. All files you have created and any software installed on the computer are permanently removed. The f11 recovery tool reinstalls the operating system and HP programs and drivers that were installed at the factory. Software not installed at the factory must be reinstalled.

To recover the original hard drive image using f11, follow these steps:

- 1. If possible, back up all personal files.
- If possible, check for the presence of the HP Recovery partition. To find the partition, select Start > Computer.
- NOTE: If the HP Recovery partition has been deleted, you must recover your operating system and programs using the Windows Vista operating system DVD and the *Driver Recovery* disc (both purchased separately). For additional information, refer to the "Using a Windows Vista operating system DVD (purchased separately)" section in this guide.
- Turn on or restart the computer, and then press esc while the "Press the ESC key for Startup Menu" message is displayed at the bottom of the screen.
- 4. Press f11 while the "Press <F11> for recovery" message is displayed on the screen.
- 5. Follow the on-screen instructions.

Using a Windows Vista operating system DVD (purchased separately)

If you are unable to boot (start up) your computer, you must purchase a Windows Vista operating system DVD to reboot the computer and repair the operating system. Make sure that your most recent backup (stored on discs or on an external drive) is easily accessible. To order a Windows Vista operating system DVD, go to <u>http://www.hp.com/support</u>, select your country or region, and follow the on-screen instructions. You can also order the DVD by calling technical support. For contact information, refer to the *Worldwide Telephone Numbers* booklet included with the computer.

△ CAUTION: Using a Windows Vista operating system DVD completely erases hard drive contents and reformats the hard drive. All files you have created and any software installed on the computer are permanently removed. When reformatting is complete, the recovery process helps you restore the operating system, as well as drivers, software, and utilities.

To initiate recovery using a Windows Vista operating system DVD, follow these steps:

- **NOTE:** This process takes several minutes.
 - 1. If possible, back up all personal files.
 - 2. Restart the computer, and then insert the Windows Vista operating system DVD into the optical drive before the Windows operating system loads.
 - 3. When prompted, press any keyboard key.
 - 4. Follow the on-screen instructions.
 - 5. Click Next.
 - 6. Select Repair your computer.
 - 7. Follow the on-screen instructions.

Windows XP backup and recovery

Use the instructions in this section if Windows XP is installed on your computer.

To protect your information, use the Windows® Backup utility (select models only) to back up files and folders or create recovery points. In case of system failure, you can use the backup files to restore your computer.

Windows provides the following options:

- Backing up individual files and folders
- Backing up all files and folders
- Scheduling automatic backups
- Creating recovery points
- Recovering information

NOTE: For detailed instructions, perform a search for these topics in Help and Support.

NOTE: In case of system instability, HP recommends that you print the recovery procedures and save them for later use.

Backing up your information

Recovery after a system failure is as complete as your most current backup. You should create your initial backup immediately after software setup. As you add new software and data files, you should continue to back up your system on a regular basis to maintain a reasonably current backup.

You can back up individual files or folders to an optional external hard drive or to a network drive.

Note the following when backing up:

- Store personal files in the My Documents folder, and back it up periodically.
- Back up templates stored in their associated programs.
- Save customized settings that appear in a window, toolbar, or menu bar by taking a screen shot
 of your settings. The screen shot can be a time saver if you have to reset your preferences.

To copy the screen and paste it into a word-processing document:

- a. Display the screen you want to save.
- **b.** Copy the screen image:

To copy only the active window, press alt+fn+prt sc.

To copy the entire screen, press fn+prt sc.

c. Open a word-processing document, click Edit > Paste.

The screen image is added to the document.

d. Save the document.

To create a backup using the Windows Backup utility (select models only), follow these steps:

NOTE: Be sure that the computer is connected to AC power before you start the backup process.

NOTE: The backup process may take over an hour, depending on file size and the speed of the computer.

- 1. Click Start > All Programs > Accessories > System Tools > Backup.
- 2. Follow the on-screen instructions.

Performing a recovery

In case of system failure or instability, the computer provides the following tools to recover your files:

- Windows recovery tools (select models only): You can use the Windows Backup utility to recover information you have previously backed up.
- Operating System and Driver Recovery discs (included with your computer): You can use the discs to recover your operating system and programs installed at the factory.

Recovering your information

To recover information you previously backed up, follow these steps:

- 1. If possible, back up all personal files.
- 2. Click Start > All Programs > Accessories > System Tools > Backup.

The Backup or Restore Wizard opens.

- 3. Click **Restore files and settings**, and then click **Next**.
- Follow the on-screen instructions.
- NOTE: For additional information on initiating a recovery in Windows, perform a search for this topic in Help and Support.

Recovering the operating system and programs

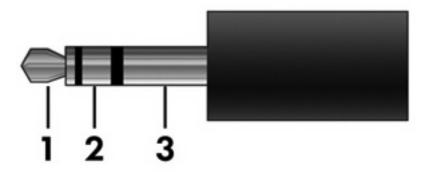
△ CAUTION: The recovery process reformats and completely erases the hard drive. All files you have created and any software installed on the computer are permanently removed. The recovery process reinstalls the original operating system, software, and drivers. Software, drivers, and updates not installed by HP must be manually reinstalled.

To recover your operating system and programs, follow these steps:

- 1. If possible, back up all personal files.
- 2. Insert the *Operating System* disc into the optical drive.
- 3. Shut down the computer.
- 4. Turn on the computer.
- 5. Follow the on-screen instructions to install the operating system.
- 6. After the operating system is installed, remove the *Operating System* disc and insert the *Driver Recovery* disc.
- 7. Follow the on-screen instructions to install the drivers and programs.

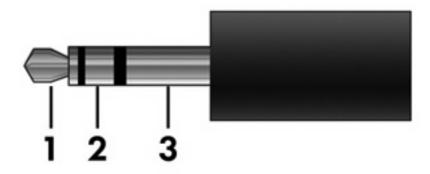
9 Connector pin assignments

Audio-in (microphone)



Pin	Signal
1	Audio signal in
2	Audio signal in
3	Ground

Audio-out (headphone)



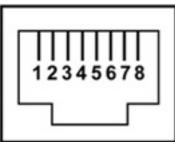
Pin	Signal	
1	Audio out, left channel	
2	Audio out, right channel	
3	Ground	

External monitor

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Pin	Signal
1	Red analog
2	Green analog
3	Blue analog
4	Not connected
5	Ground
6	Ground analog
7	Ground analog
8	Ground analog
9	+5 VDC
10	Ground
11	Monitor detect
12	DDC 2B data
13	Horizontal sync
14	Vertical sync
15	DDC 2B clock

RJ-45 (network)



<u> </u>	
Pin	Signal
1	Transmit +
2	Transmit -
3	Receive +
4	Unused
5	Unused
6	Receive -
7	Unused
8	Unused

Universal Serial Bus



Pin	Signal
1	+5 VDC
2	Data -
3	Data +
4	Ground

10 Power cord set requirements

The wide range input feature of the device permits it to operate from any line voltage from 100 to 120 volts AC or from 220 to 240 volts AC.

The 3-conductor power cord set included with the device meets the requirements for use in the country or region where the equipment is purchased.

Power cord sets for use in other countries and regions must meet the requirements of the country or region where the device is used.

Requirements for all countries and regions

The requirements listed below are applicable to all countries and regions:

- The length of the power cord set must be at least 1.5 m (5.0 ft) and no more than 2.0 m (6.5 ft).
- All power cord sets must be approved by an acceptable accredited agency responsible for evaluation in the country or region where the power cord set will be used.
- The power cord sets must have a minimum current capacity of 10 amps and a nominal voltage rating of 125 or 250 V AC, as required by the power system of each country or region.
- The appliance coupler must meet the mechanical configuration of an EN 60 320/IEC 320 Standard Sheet C13 connector for mating with the appliance inlet on the back of the device.

Requirements for specific countries and regions

Country/region	Accredited agency	Applicable note number
Australia	EANSW	1
Austria	OVE	1
Belgium	CEBC	1
Canada	CSA	2
Denmark	DEMKO	1
Finland	FIMKO	1
France	UTE	1
Germany	VDE	1
Italy	IMQ	1
Japan	METI	3
The Netherlands	KEMA	1
Norway	NEMKO	1
The People's Republic of China	CCC	5
South Korea	EK	4
Sweden	SEMKO	1
Switzerland	SEV	1
Taiwan	BSMI	4
The United Kingdom	BSI	1
The United States	UL	2

1. The flexible cord must be Type HO5VV-F, 3-conductor, 1.0-mm² conductor size. Power cord set fittings (appliance coupler and wall plug) must bear the certification mark of the agency responsible for evaluation in the country or region where it will be used.

- 2. The flexible cord must be Type SPT-3 or equivalent, No. 18 AWG, 3-conductor. The wall plug must be a two-pole grounding type with a NEMA 5-15P (15 A, 125 V) or NEMA 6-15P (15 A, 250 V) configuration.
- 3. The appliance coupler, flexible cord, and wall plug must bear a "T" mark and registration number in accordance with the Japanese Dentori Law. The flexible cord must be Type VCT or VCTF, 3-conductor, 1.00-mm² conductor size. The wall plug must be a two-pole grounding type with a Japanese Industrial Standard C8303 (7 A, 125 V) configuration.
- 4. The flexible cord must be Type RVV, 3-conductor, 0.75-mm² conductor size. Power cord set fittings (appliance coupler and wall plug) must bear the certification mark of the agency responsible for evaluation in the country or region where it will be used.
- The flexible cord must be Type VCTF, 3-conductor, 0.75-mm² conductor size. Power cord set fittings (appliance coupler and wall plug) must bear the certification mark of the agency responsible for evaluation in the country or region where it will be used.

11 Recycling

Battery

When a battery has reached the end of its useful life, do not dispose of the battery in general household waste. Follow the local laws and regulations in your area for computer battery disposal.

Display

- ▲ WARNING! The backlight contains mercury. Exercise caution when removing and handling the backlight to avoid damaging this component and causing exposure to the mercury.
- △ CAUTION: The procedures in this chapter can result in damage to display components. The only components intended for recycling purposes are the liquid crystal display (LCD) panel and the backlight. When you remove these components, handle them carefully.
- NOTE: Materials Disposal. This HP product contains mercury in the backlight in the display assembly that might require special handling at end-of-life. Disposal of mercury may be regulated because of environmental considerations. For disposal or recycling information, contact your local authorities, or see the Electronic Industries Alliance (EIA) Web site at http://www.eiae.org.

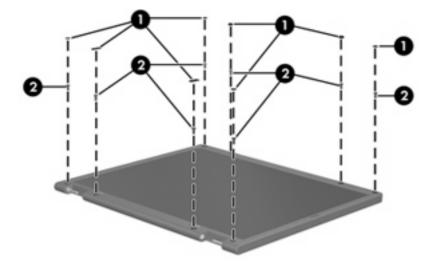
This section provides disassembly instructions for the display assembly. The display assembly must be disassembled to gain access to the backlight (1) and the liquid crystal display (LCD) panel (2).



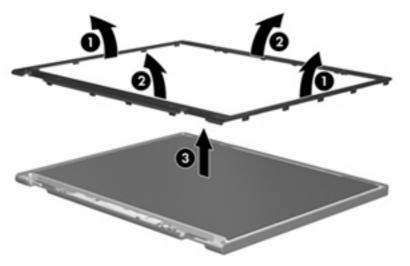
NOTE: The procedures provided in this chapter are general disassembly instructions. Specific details, such as screw sizes, quantities, and locations, and component shapes and sizes, can vary from one computer model to another.

Perform the following steps to disassemble the display assembly:

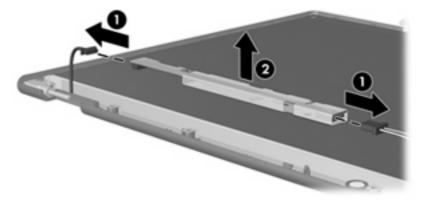
1. Remove all screw covers (1) and screws (2) that secure the display bezel to the display assembly.



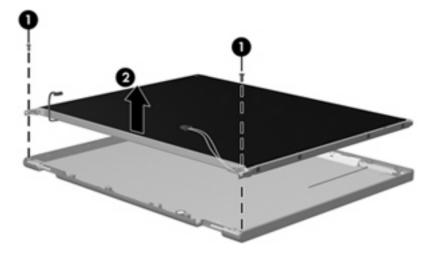
- 2. Lift up and out on the left and right inside edges (1) and the top and bottom inside edges (2) of the display bezel until the bezel disengages from the display assembly.
- **3.** Remove the display bezel **(3)**.



4. Disconnect all display panel cables (1) from the display inverter and remove the inverter (2).

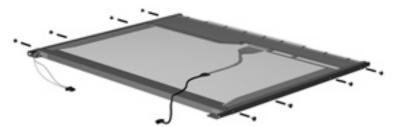


5. Remove all screws (1) that secure the display panel assembly to the display enclosure.



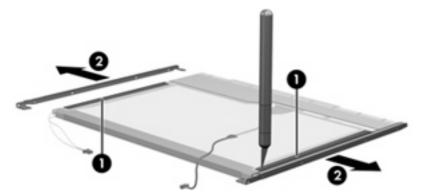
6. Remove the display panel assembly (2) from the display enclosure.

- 7. Turn the display panel assembly upside down.
- 8. Remove all screws that secure the display panel frame to the display panel.

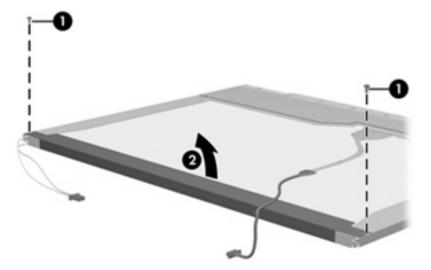


9. Use a sharp-edged tool to cut the tape (1) that secures the sides of the display panel to the display panel frame.

10. Remove the display panel frame **(2)** from the display panel.

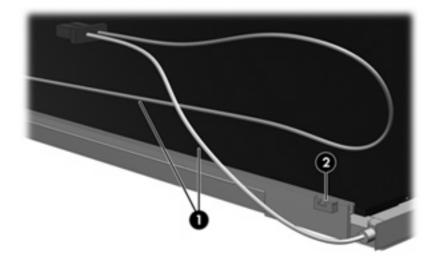


- **11.** Remove the screws **(1)** that secure the backlight cover to the display panel.
- **12.** Lift the top edge of the backlight cover **(2)** and swing it outward.

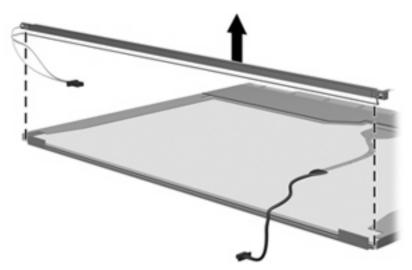


- **13.** Remove the backlight cover.
- **14.** Turn the display panel right-side up.

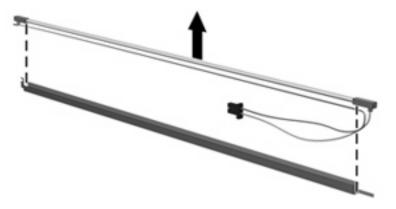
15. Remove the backlight cables **(1)** from the clip **(2)** in the display panel.



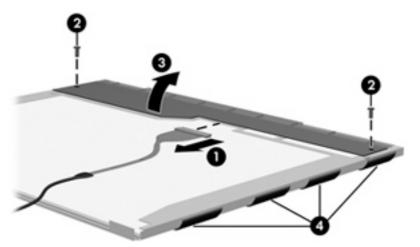
- **16.** Turn the display panel upside down.
- ▲ WARNING! The backlight contains mercury. Exercise caution when removing and handling the backlight to avoid damaging this component and causing exposure to the mercury.
- **17.** Remove the backlight frame from the display panel.



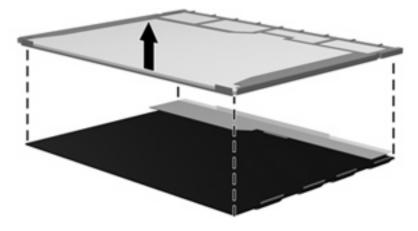
18. Remove the backlight from the backlight frame.



- **19.** Disconnect the display panel cable **(1)** from the LCD panel.
- 20. Remove the screws (2) that secure the LCD panel to the display rear panel.
- 21. Release the LCD panel (3) from the display rear panel.
- 22. Release the tape (4) that secures the LCD panel to the display rear panel.



23. Remove the LCD panel.



24. Recycle the LCD panel and backlight.

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